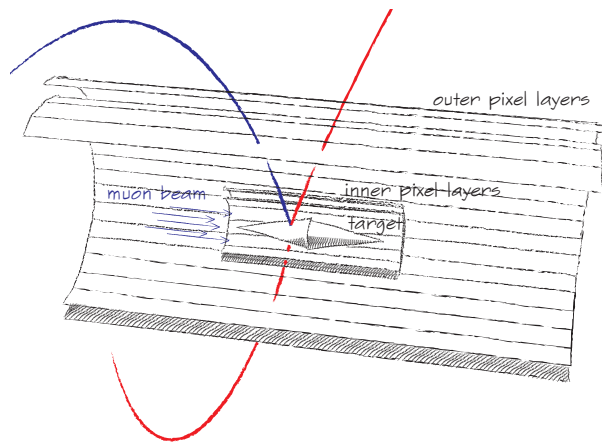


Mu3e

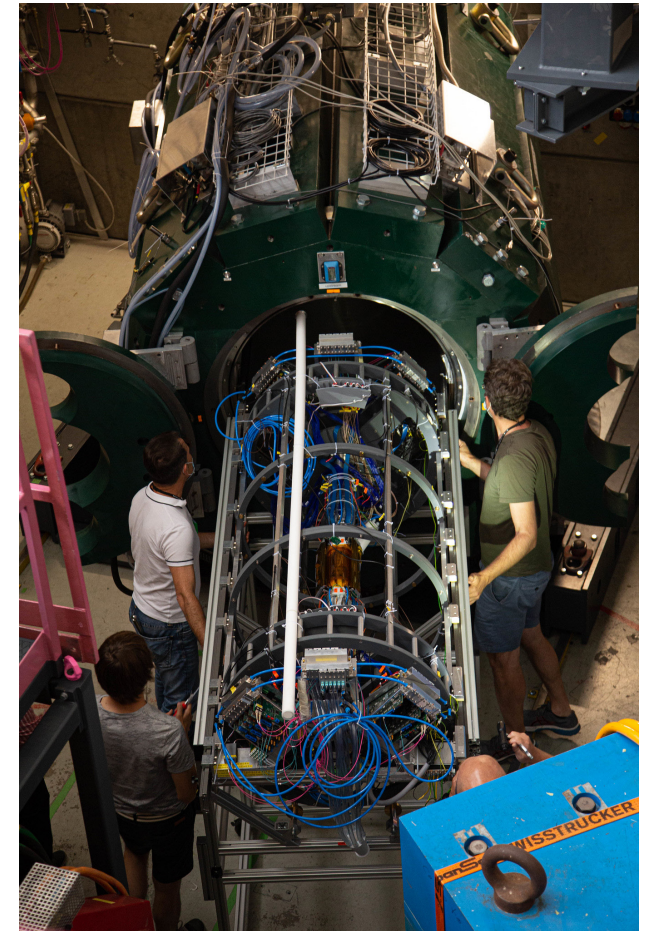
from idea to Experiment



Niklaus Berger

Institut für Kernphysik,
Johannes Gutenberg Universität
Mainz

MPIP München
June 2024





Particle Physics 2024:

- All particles in the Standard Model discovered
- Very few lab measurements in tension with SM
- SM known to be incomplete: Dark matter, baryon asymmetry, gravity, hierarchy,...





Particle Physics 2024:

- All particles in the Standard Model discovered
- Very few lab measurements in tension with SM
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- Where to look for new physics?





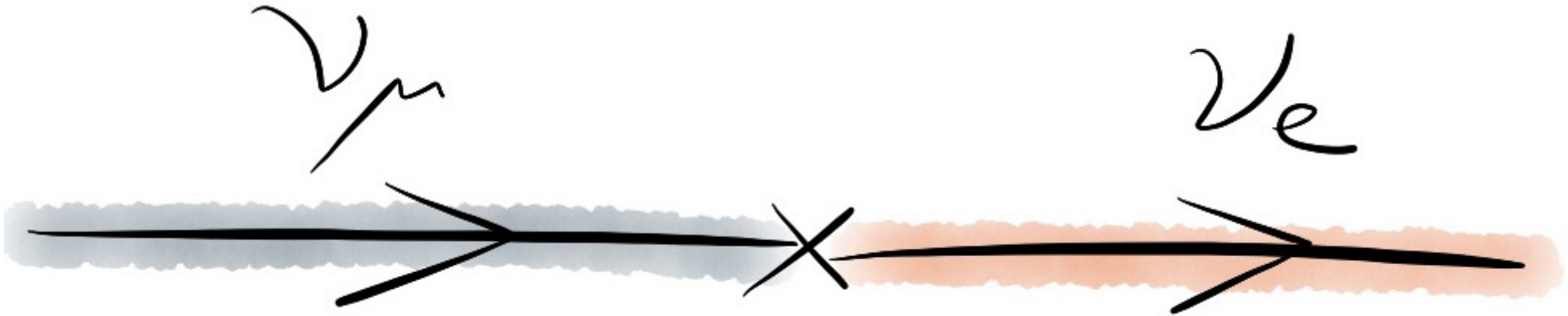
Particle Physics 2024:

- All particles in the Standard Model discovered
- Very few lab measurements in tension with SM
- SM known to be incomplete: Dark matter, baryon asymmetry, gravity, hierarchy,...
- Where to look for new physics?
- Where do we see physics beyond the standard model already?



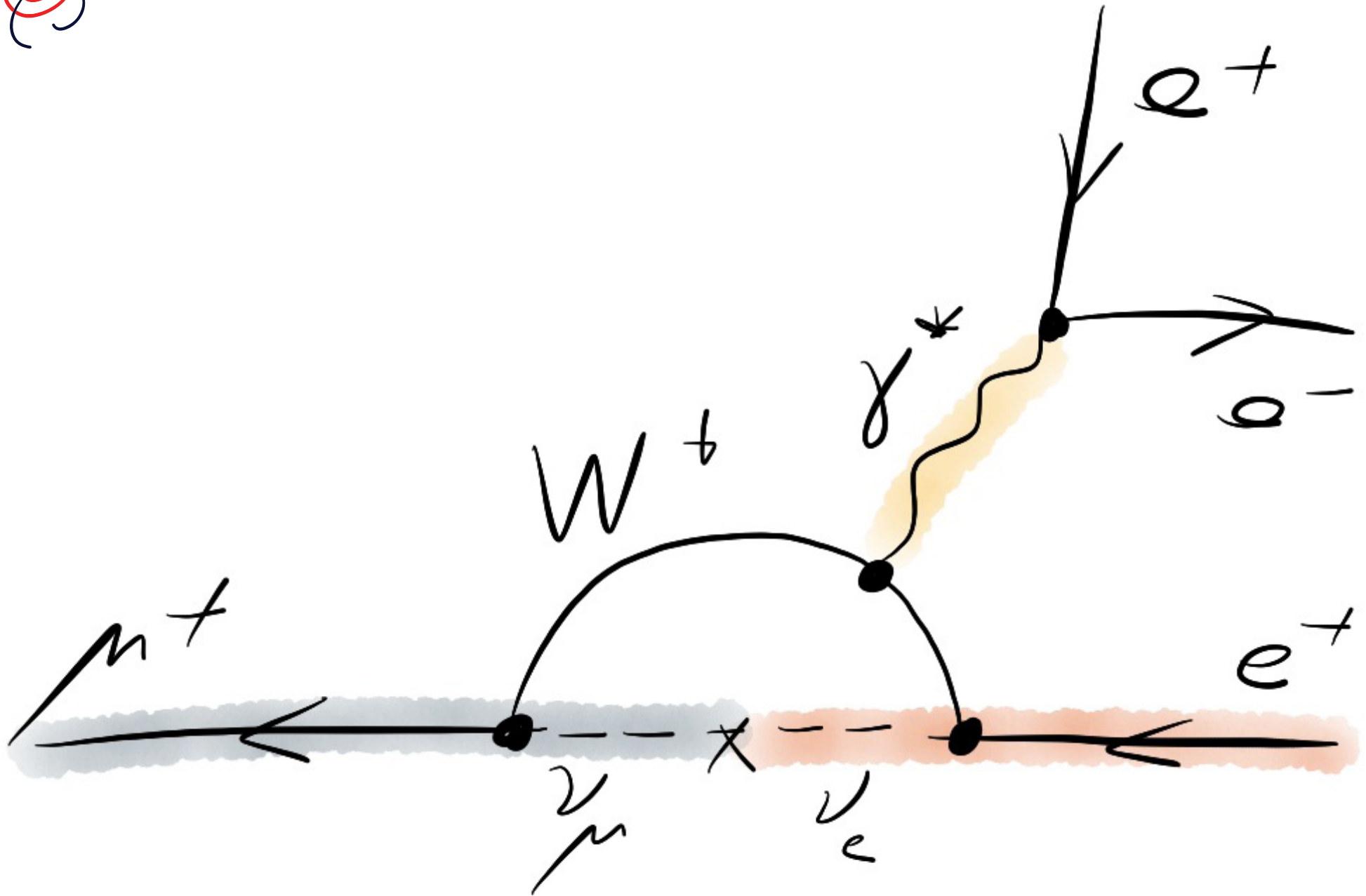


Lepton Flavour Violation!





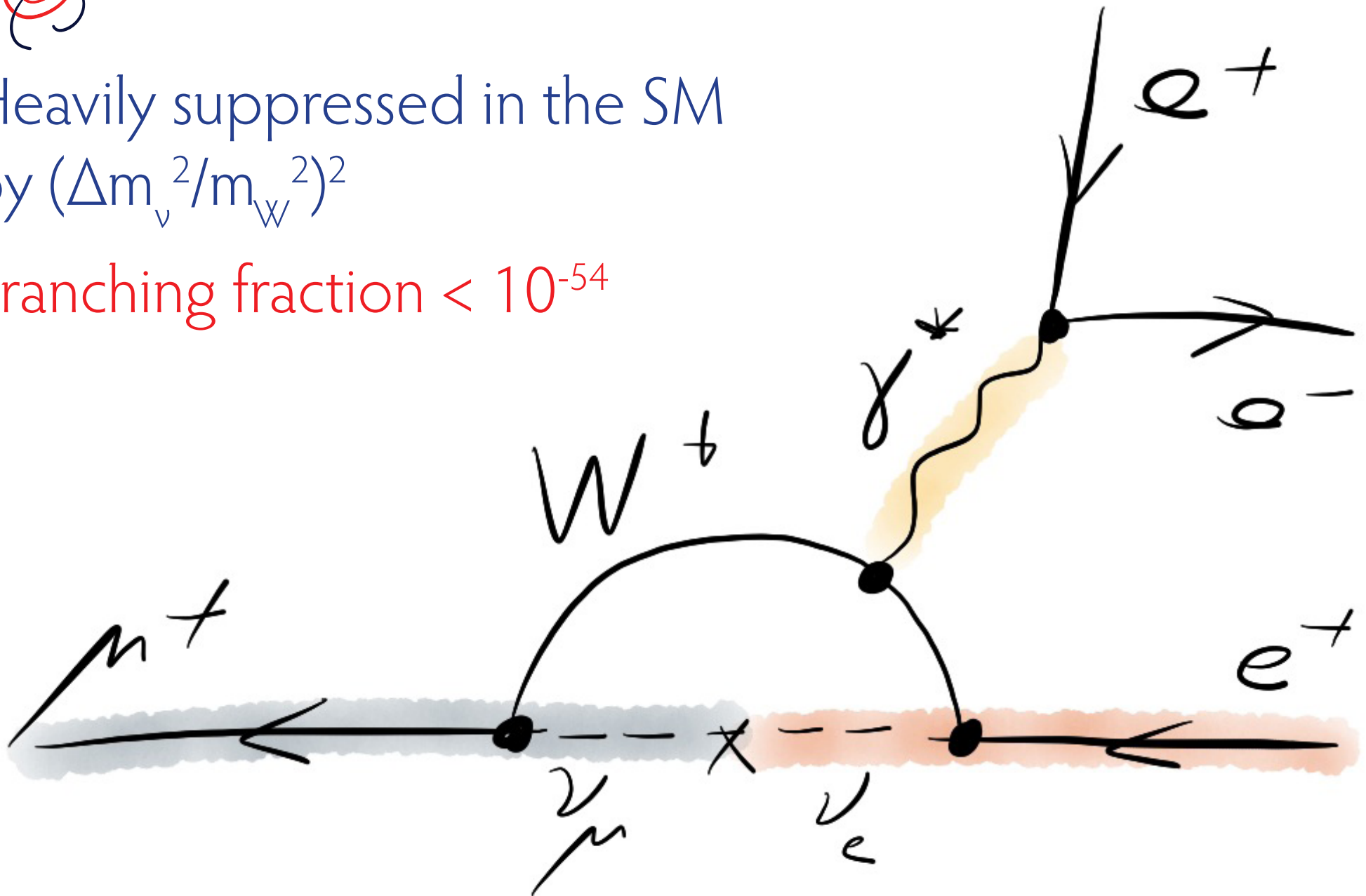
Charged Lepton Flavour Violation?



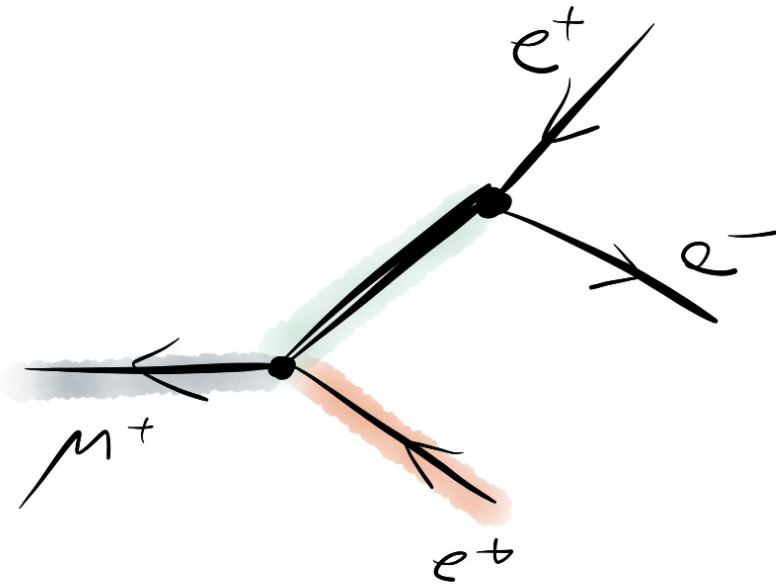
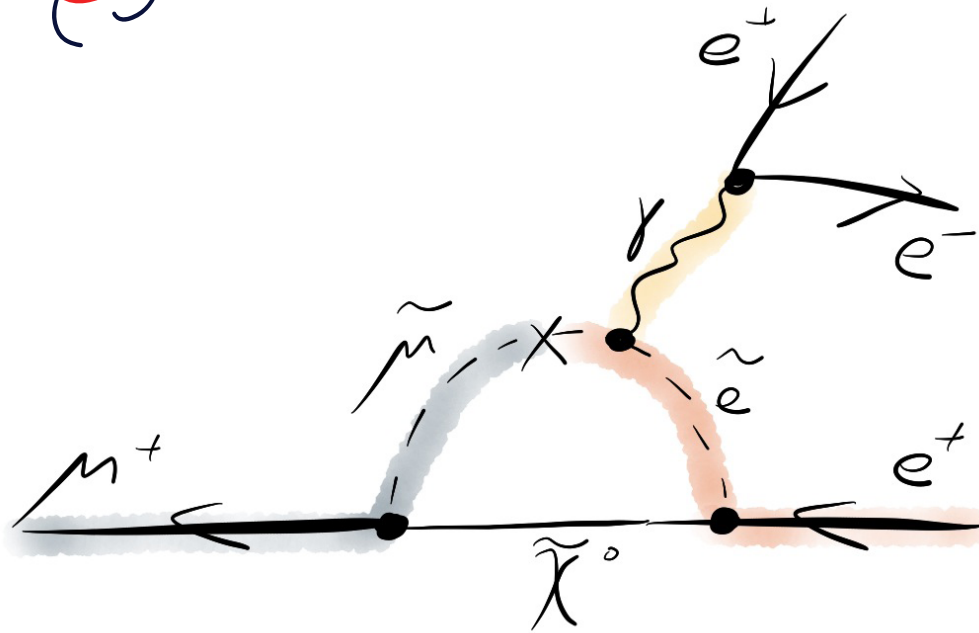
Charged Lepton Flavour Violation?

Heavily suppressed in the SM
by $(\Delta m_\nu^2/m_W^2)^2$

Branching fraction $< 10^{-54}$



New physics in $\mu^+ \rightarrow e^+e^-e^+$



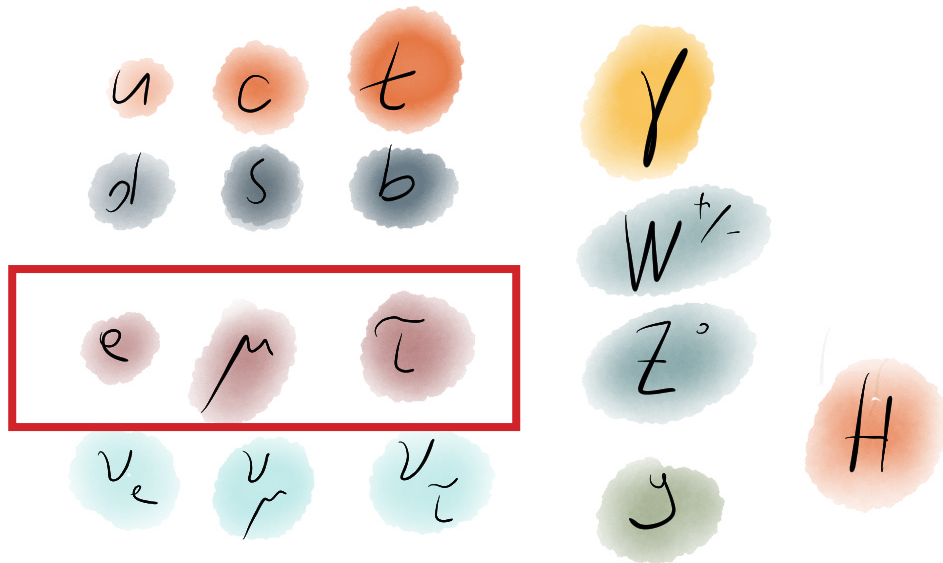
Loop diagrams

- Supersymmetry
- Little Higgs models
- Seesaw models
- GUT models (leptoquarks)
- and much more...

Tree diagrams

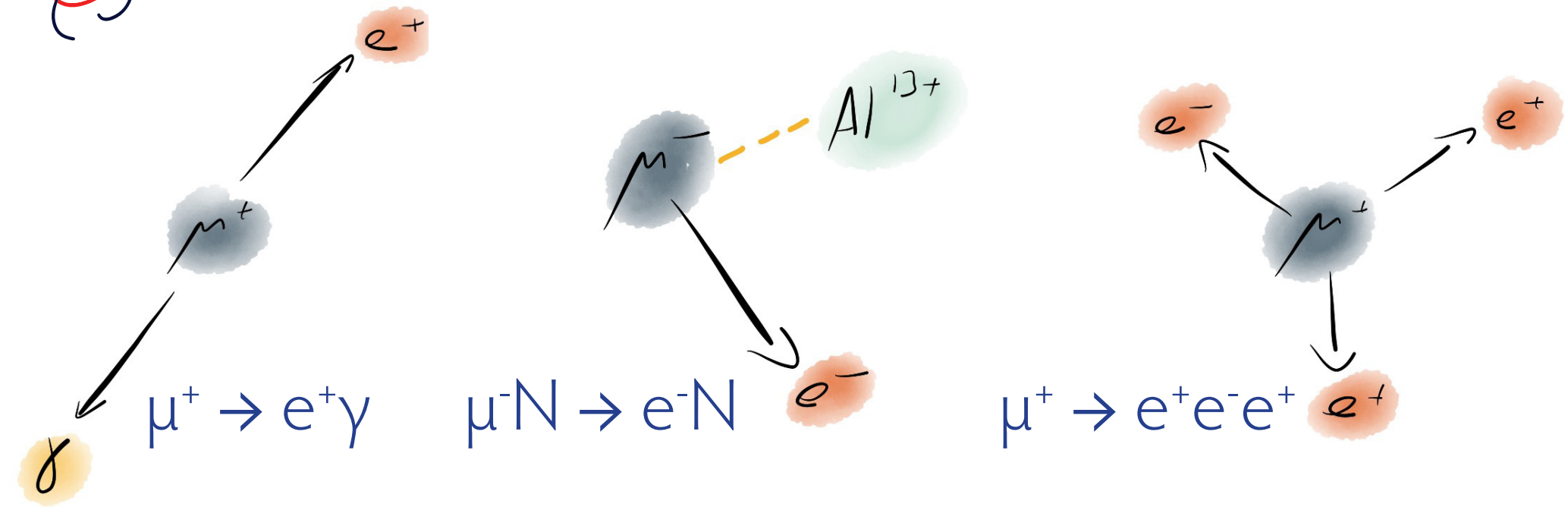
- Higgs triplet model
- Extra heavy vector bosons (Z')
- Extra dimensions (Kaluza-Klein tower)
- ...

Menu of charged Leptons

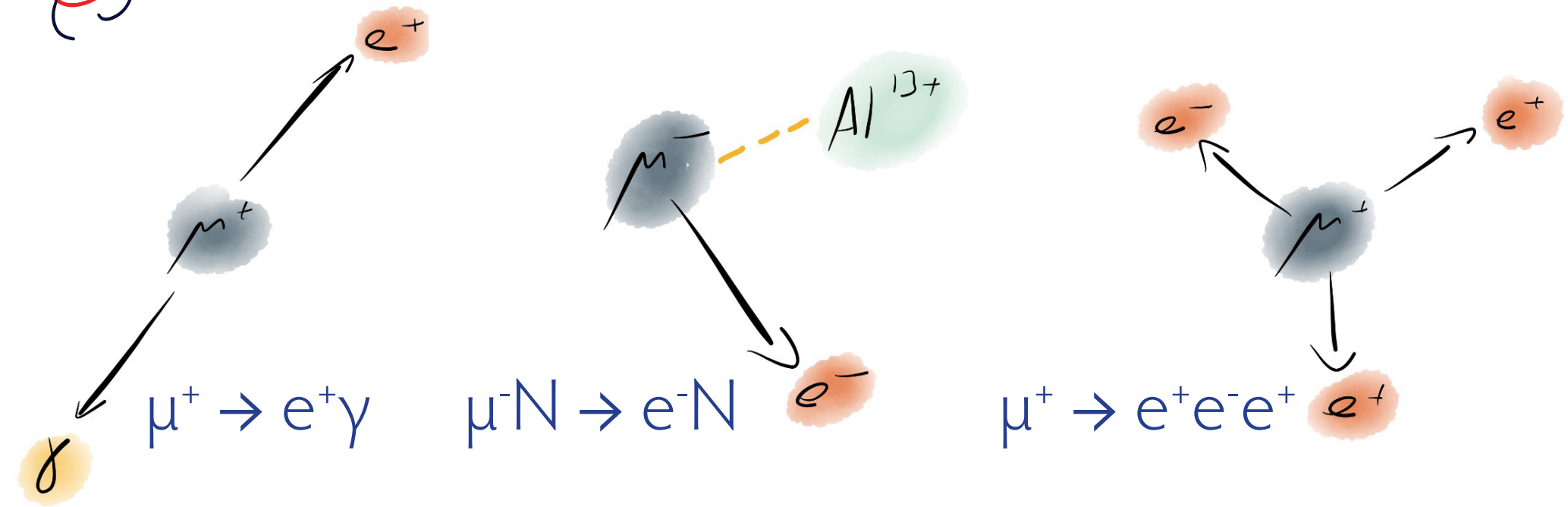


- Electrons are stable...
- New physics sensitivity (heavy new physics, very generic) scales with m_l^2
 τ 's are most sensitive
- But: Can produce about as many muons per second as taus in a year
- Muons lead the search for charged Lepton Flavour Violation

LFV Muon Decays: Experimental Situation



LFV Muon Decays: Experimental Situation



MEG/MEG II (PSI)

$$B(\mu^+ \rightarrow e^+ \gamma) < 3.1 \cdot 10^{-13}$$

(2024)

SINDRUM II (PSI)

$$B(\mu^- Au \rightarrow e^- Au) < 7 \cdot 10^{-13}$$

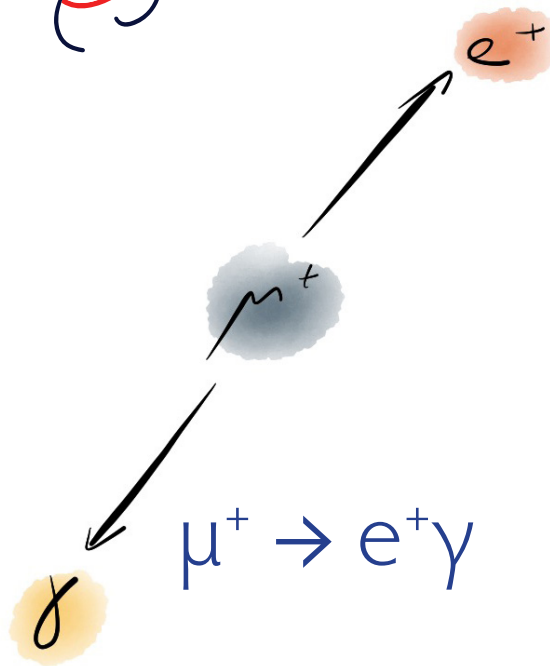
(2006)

SINDRUM (PSI)

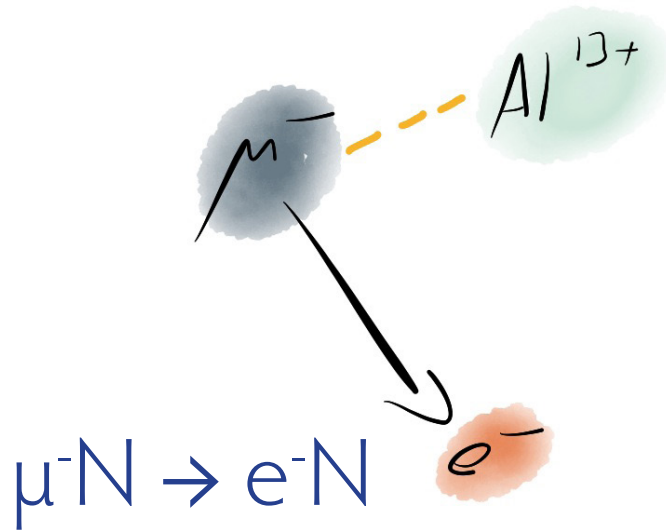
$$B(\mu^+ \rightarrow e^+ e^- e^+) < 1.0 \cdot 10^{-12}$$

(1988)

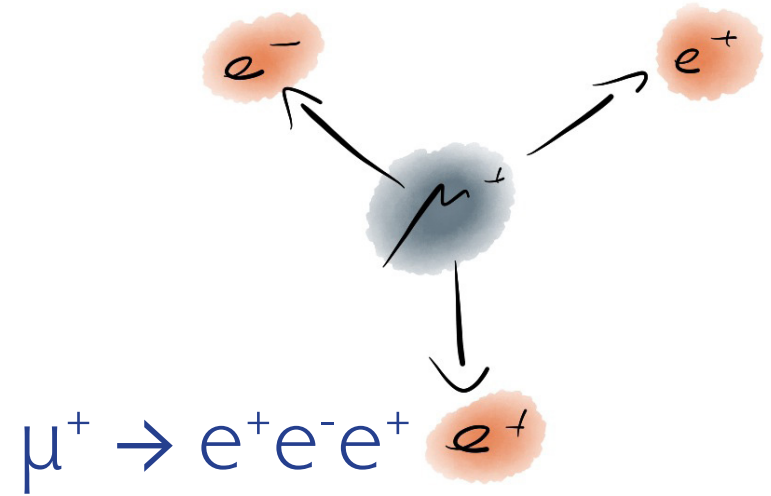
LFV Muon Decays: Experimental Situation



$$\mu^+ \rightarrow e^+ \gamma$$



$$\mu^- N \rightarrow e^- N$$



$$\mu^+ \rightarrow e^+ e^- e^+$$

MEG (PSI)

$$B(\mu^+ \rightarrow e^+ \gamma) < 3.1 \cdot 10^{-13}$$

(2024)

MEG II

SINDRUM II (PSI)

$$B(\mu^- Au \rightarrow e^- Au) < 7 \cdot 10^{-13}$$

(2006)

Mu2e/Comet

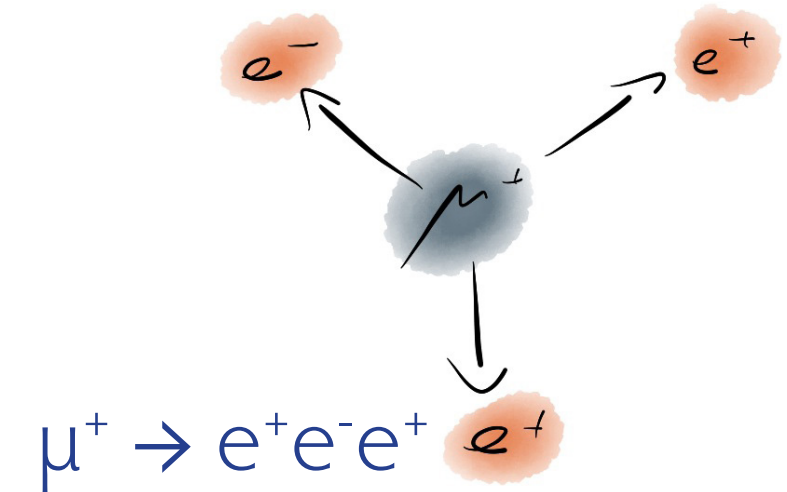
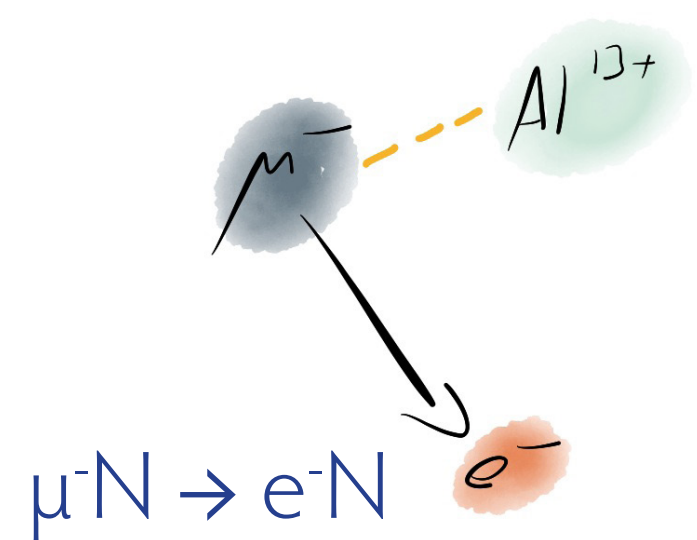
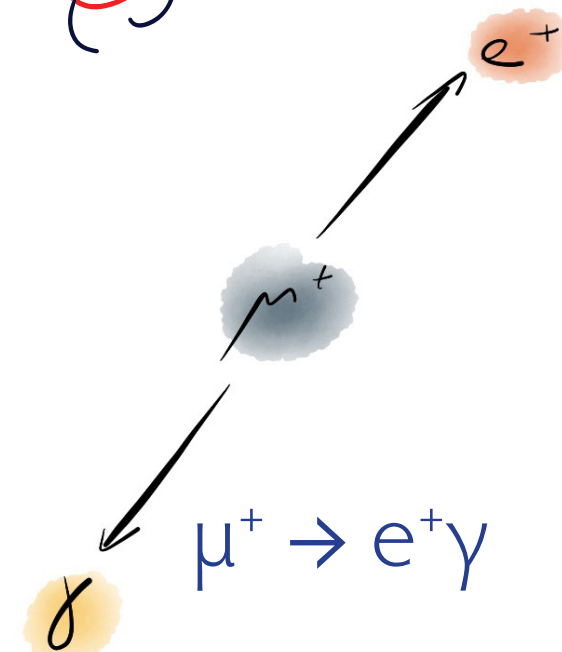
SINDRUM (PSI)

$$B(\mu^+ \rightarrow e^+ e^- e^+) < 1.0 \cdot 10^{-12}$$

(1988)

Mu3e

LFV Muon Decays: Experimental signatures



Kinematics

- 2-body decay
- Monoenergetic e^+ , γ
- Back-to-back

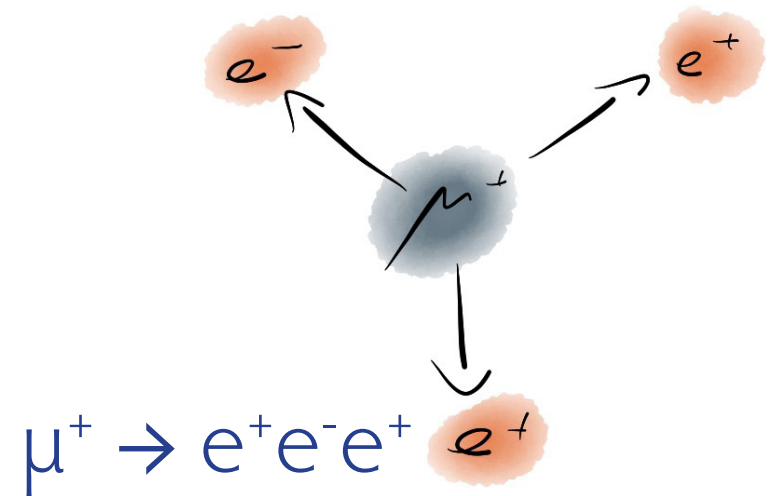
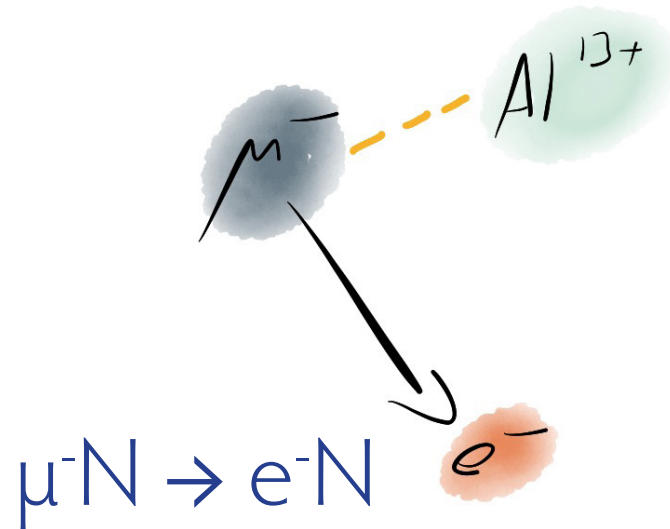
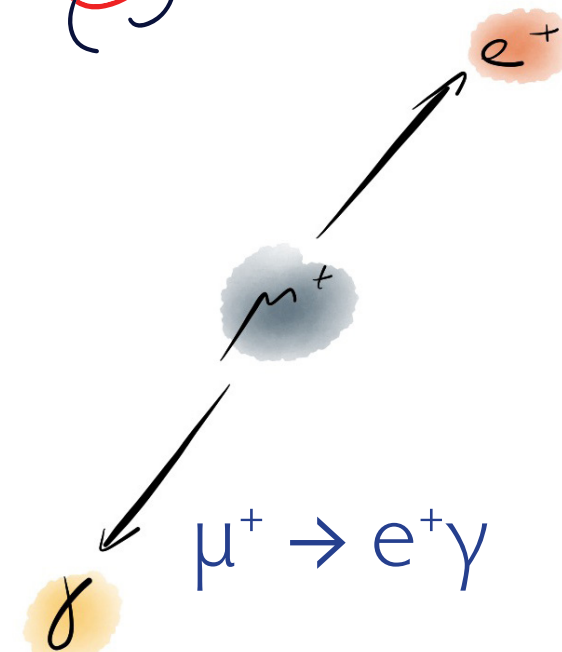
Kinematics

- Quasi 2-body decay
- Monoenergetic e^-
- Single particle detected

Kinematics

- 3-body decay
- Invariant mass constraint
- $\sum p_i = 0$

LFV Muon Decays: Experimental signatures



Kinematics

- 2-body decay
- Monoenergetic e^+ , γ
- Back-to-back

Background

- Accidental background

Kinematics

- Quasi 2-body decay
- Monoenergetic e^-
- Single particle detected

Background

- Decay in orbit
- Antiprotons, pions, cosmics

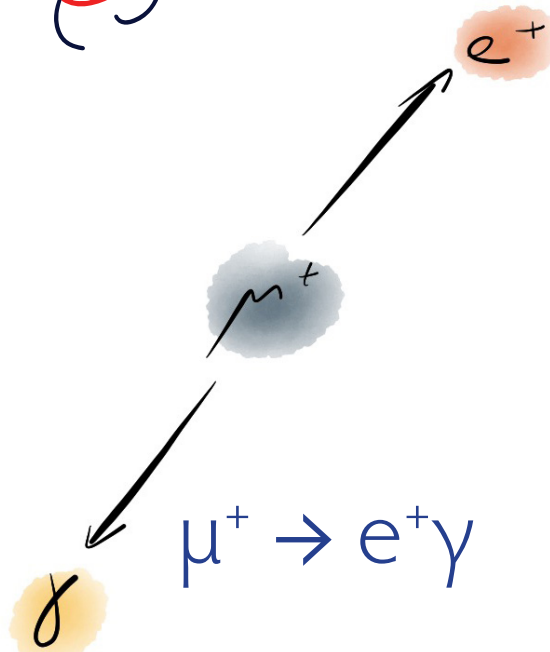
Kinematics

- 3-body decay
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- $\sum p_i = 0$

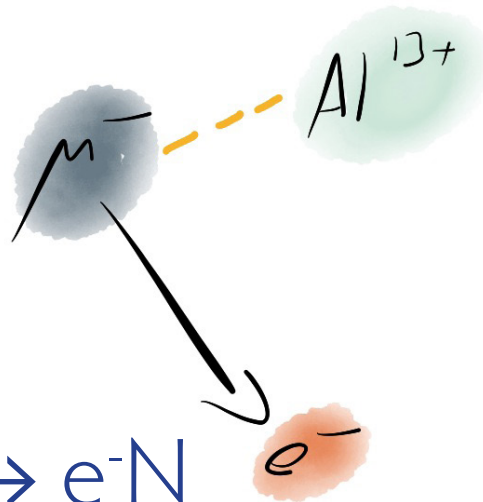
Background

- Radiative decay
- Accidental background

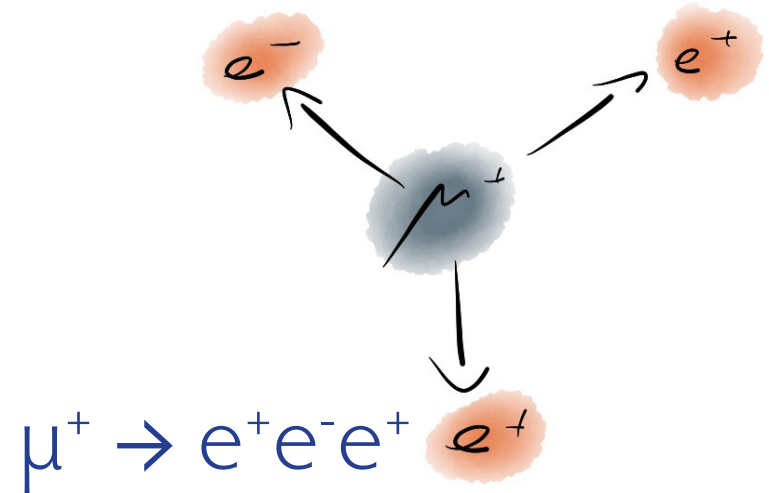
LFV Muon Decays: Experimental signatures



$$\mu^+ \rightarrow e^+ \gamma$$



$$\mu^- N \rightarrow e^- N$$



$$\mu^+ \rightarrow e^+ e^- e^+$$

Kinematics

- 2-body decay
- Monoenergetic
- Back-to-back

Background

- Atomic background

Continuous Beam

Kinematics

- Quasi 2-body decay
- Monoenergetic
- Single particle detected

Background

- Γ orbit
- Atomic protons, pions

Pulsed Beam

Kinematics

- 3-body decay
- Invariant mass constraint
- $\sum p_i = 0$

Background

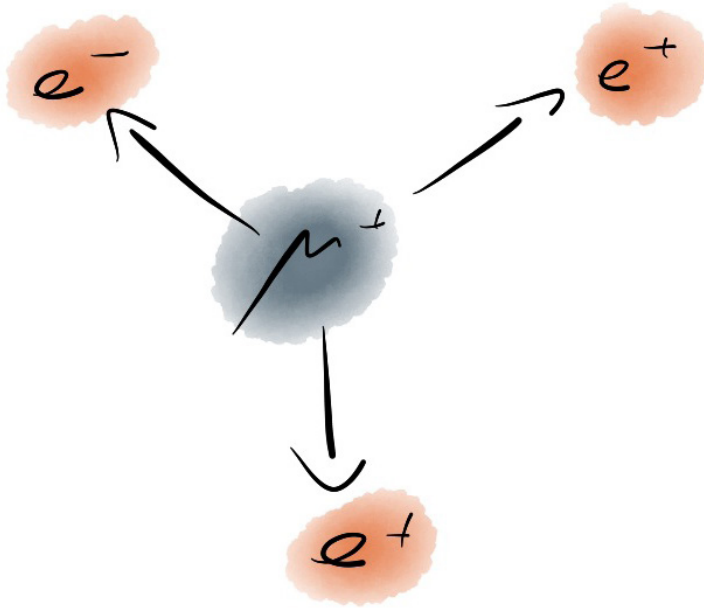
- Radiative decay
- Atomic background

Continuous Beam



The $\mu^+ \rightarrow e^+ e^- e^+$ Process: Requirements for an Experiment

The signal



- $\mu^+ \rightarrow e^+e^-e^+$
- Two positrons, one electron
- From same vertex
- Same time
- Sum of 4-momenta corresponds to muon at rest
- Maximum momentum: $\frac{1}{2} m_\mu = 53 \text{ MeV}/c$

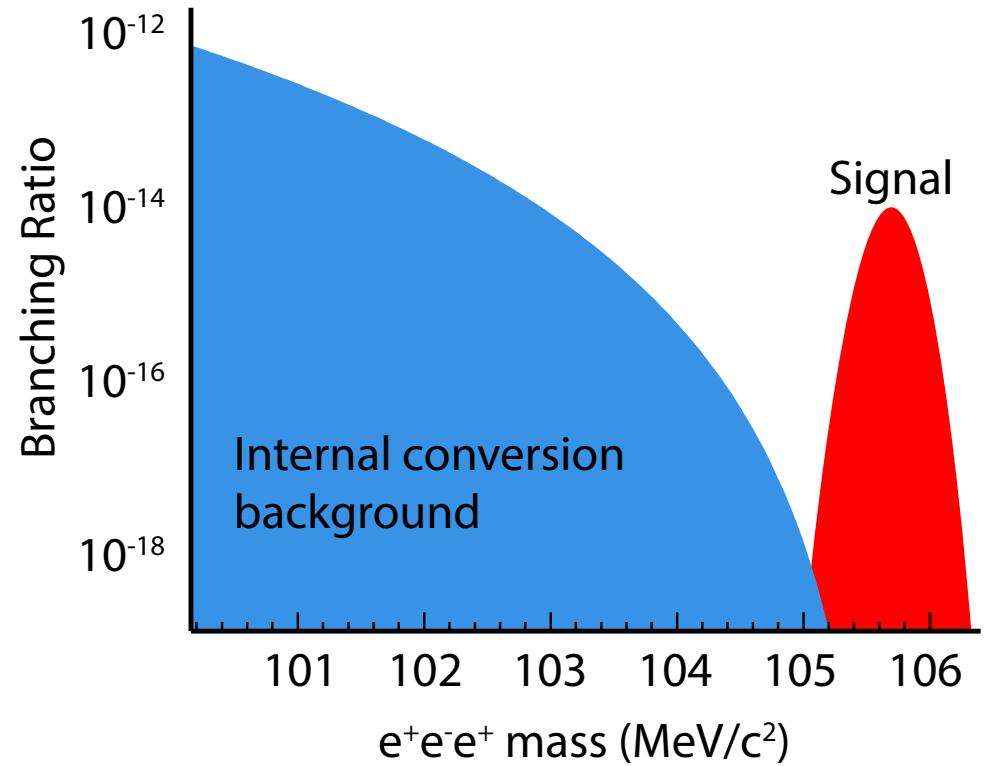
Internal conversion background



- Allowed radiative decay with internal conversion:

$$\mu^+ \rightarrow e^+e^-e^+\nu\bar{\nu}$$
- Only distinguishing feature:
 Missing momentum carried by neutrinos

- Need excellent momentum resolution





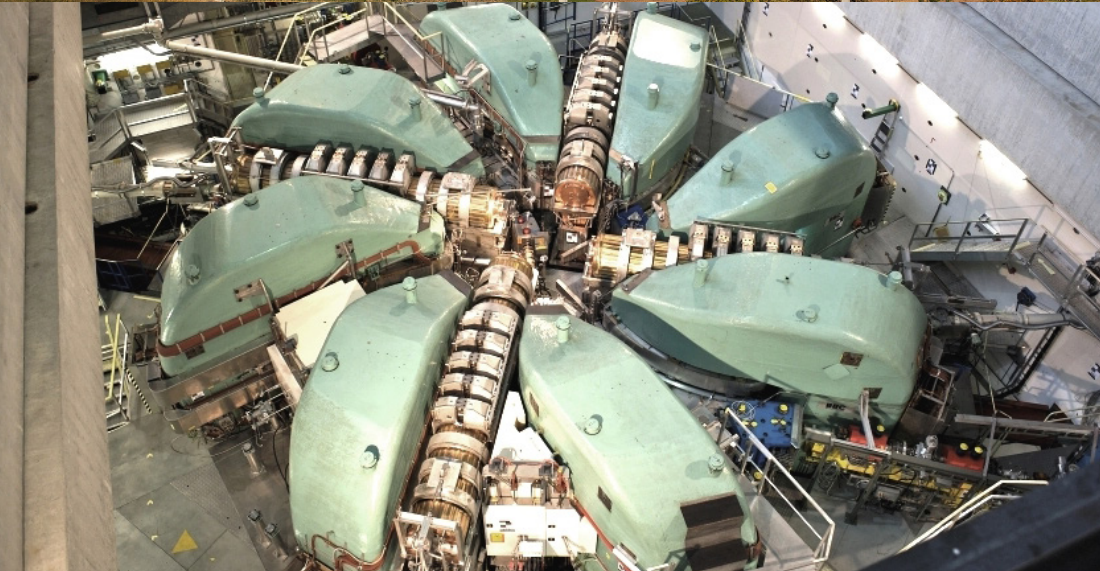
Building the Mu3e Experiment

aiming for a branching ratio sensitivity of 10^{-16}

(few 10^{-15} for the current first phase)



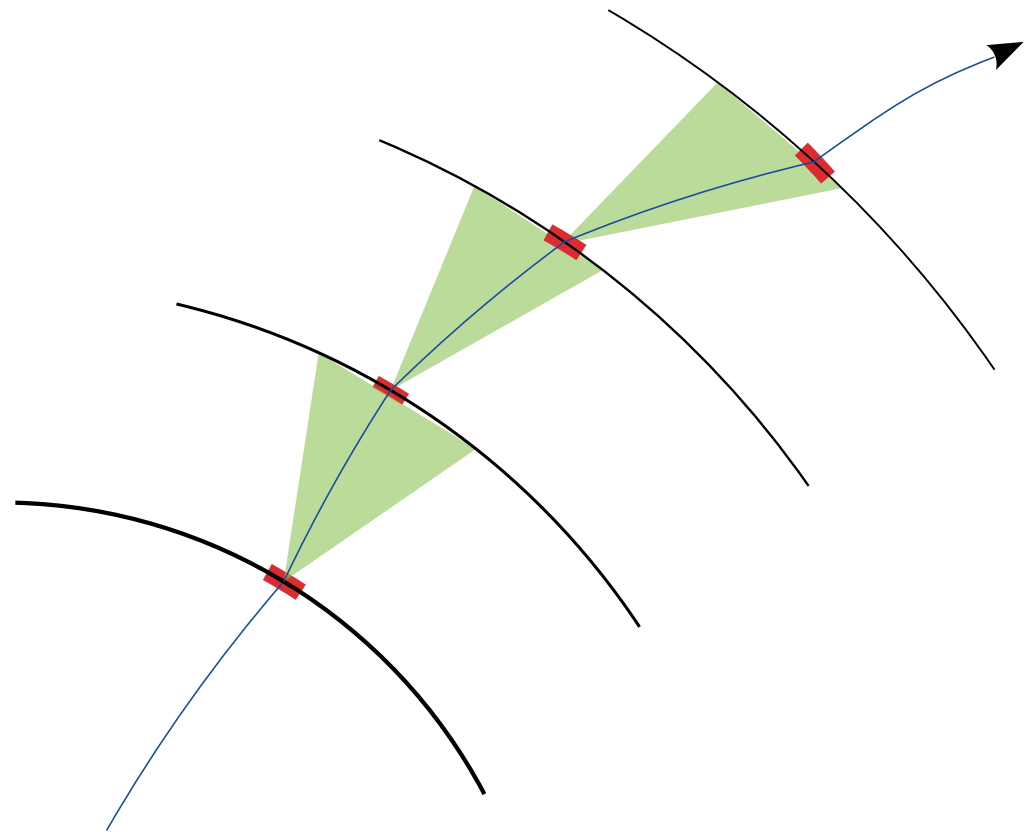
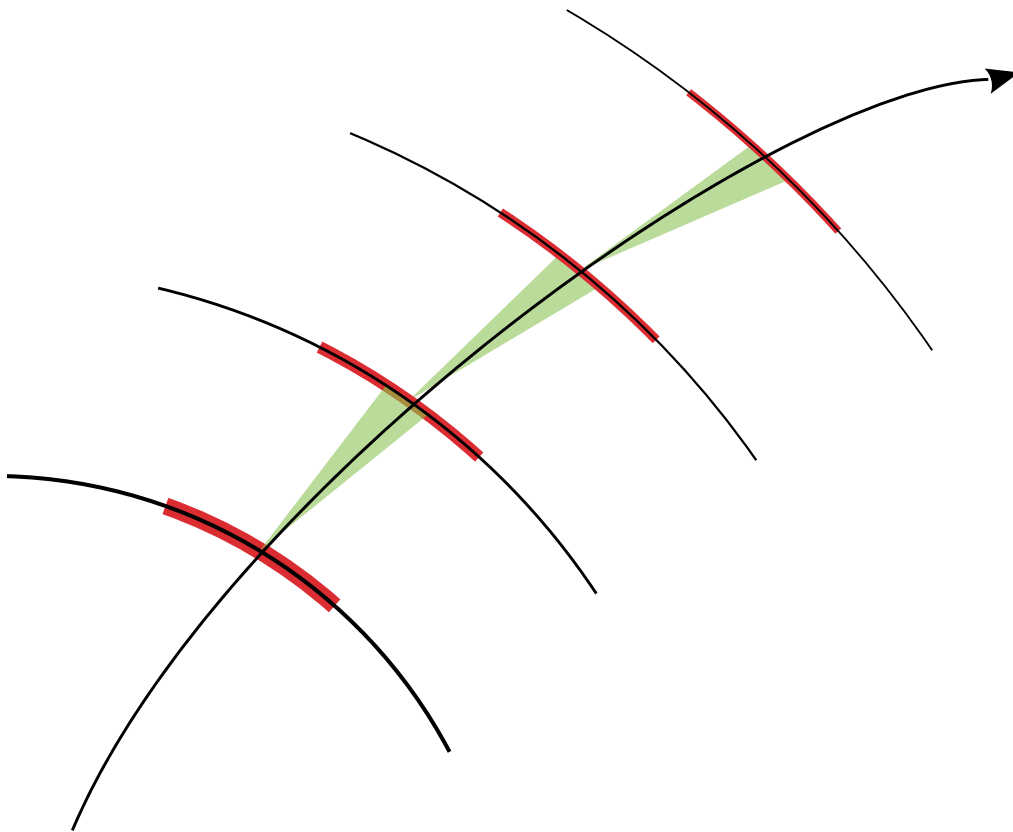
Getting Muons



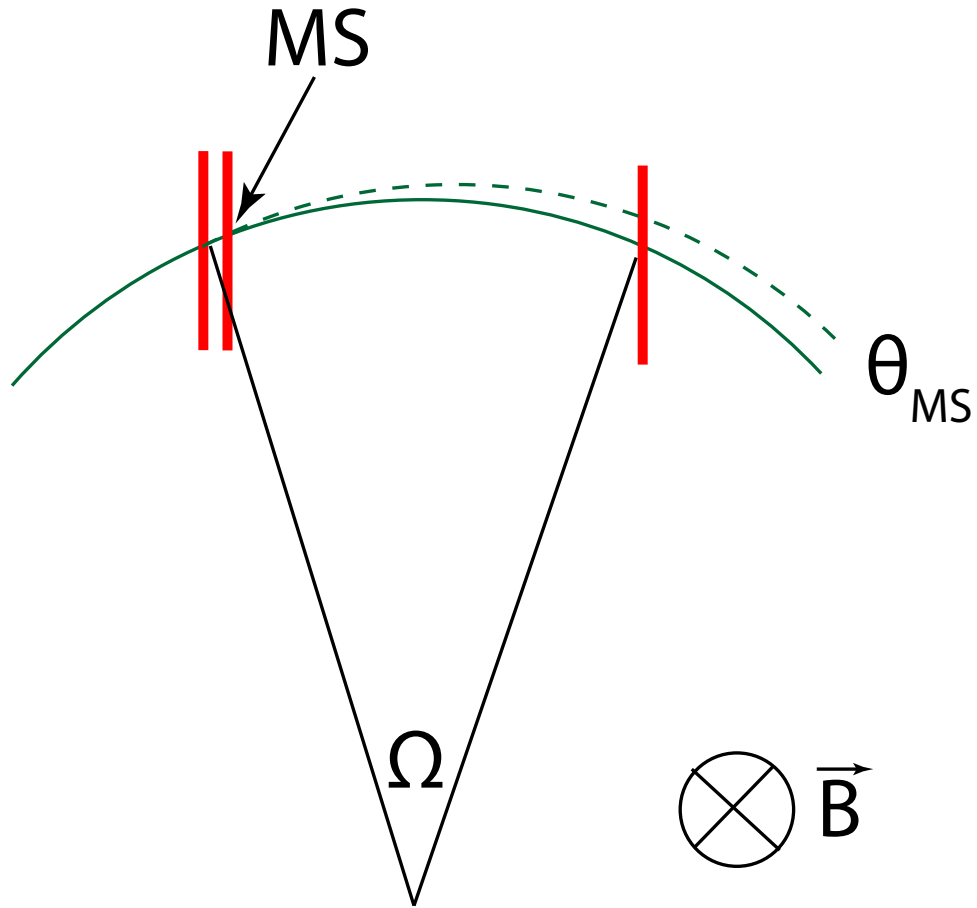
- Paul Scherrer Institute in Switzerland
- 1.4 MW, 590 MeV proton accelerator
- Carbon target, produce pions, decay to muons
- Currently: Up to 10^8 muons/s available
Mu3e Phase I
- Future (2027+): High-intensity muon beamline (HIMB) with up to 10^{10} muons/s
Mu3e Phase II
- Need to be able to stand these rates

Momentum measurement

- Apply magnetic field (e.g. 1 Tesla)
- Measure curvature of particles in field
- Limited by detector resolution and scattering in detector



Momentum measurement

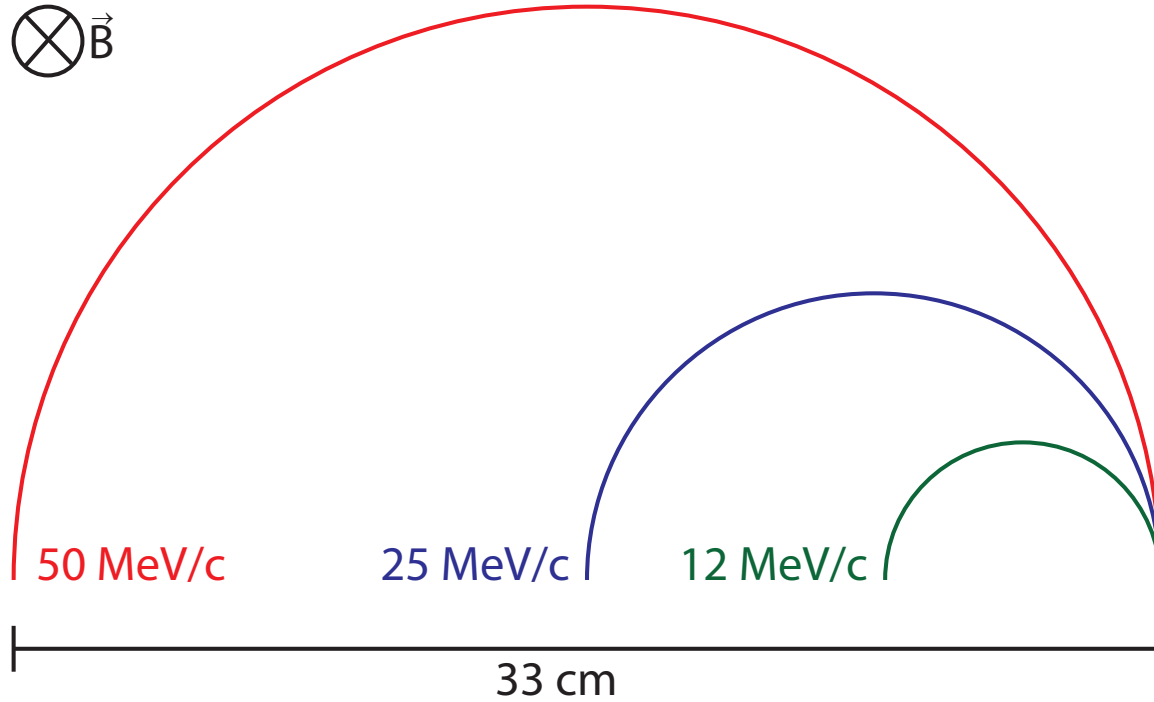


- 1 T magnetic field
- Resolution dominated by **multiple scattering**
- Momentum resolution to first order:

$$\sigma_{P/P} \sim \theta_{MS}/\Omega$$

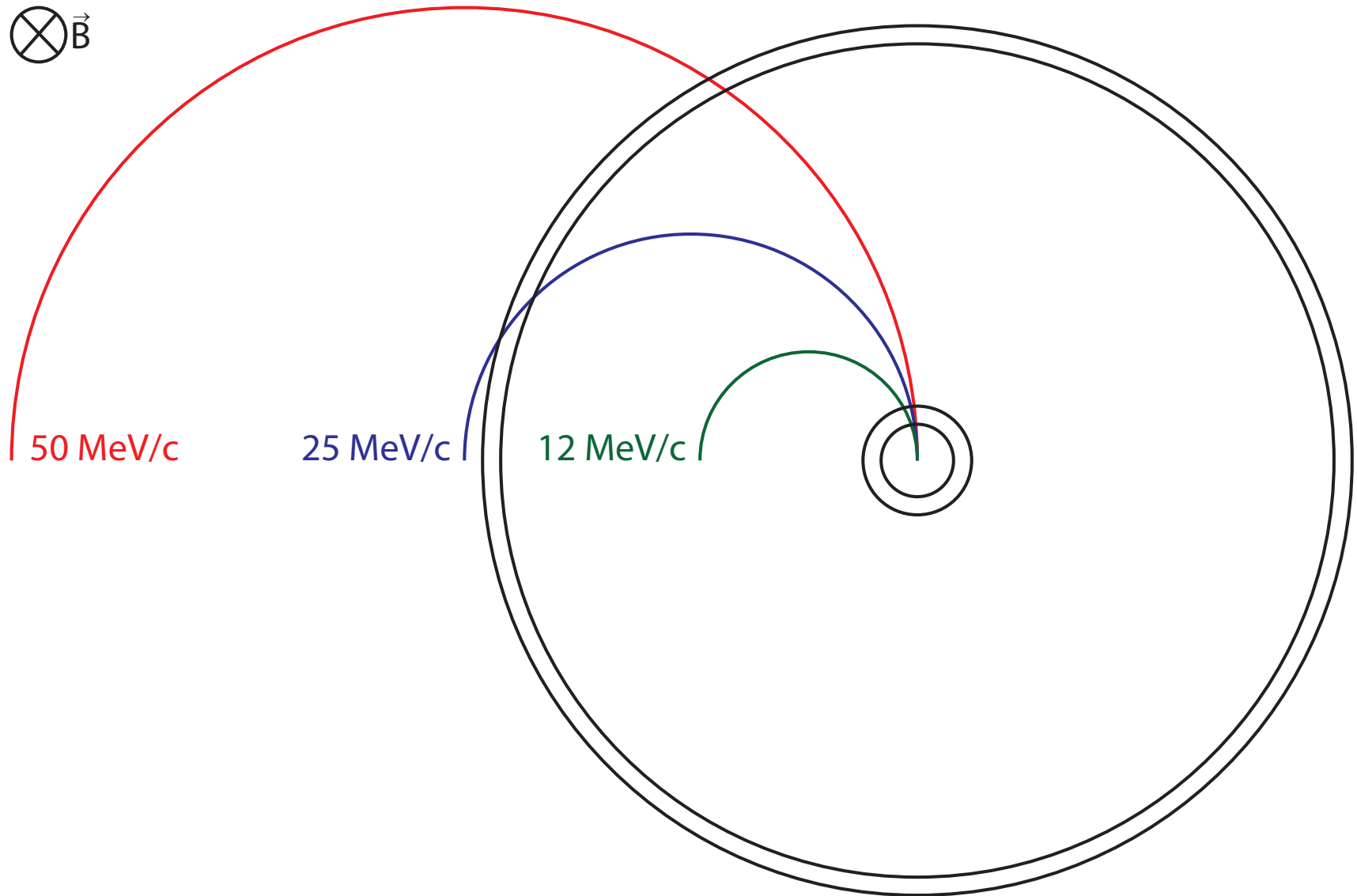
- Precision requires large lever arm (large bending angle Ω) and low multiple scattering θ_{MS}

Precision vs. Acceptance

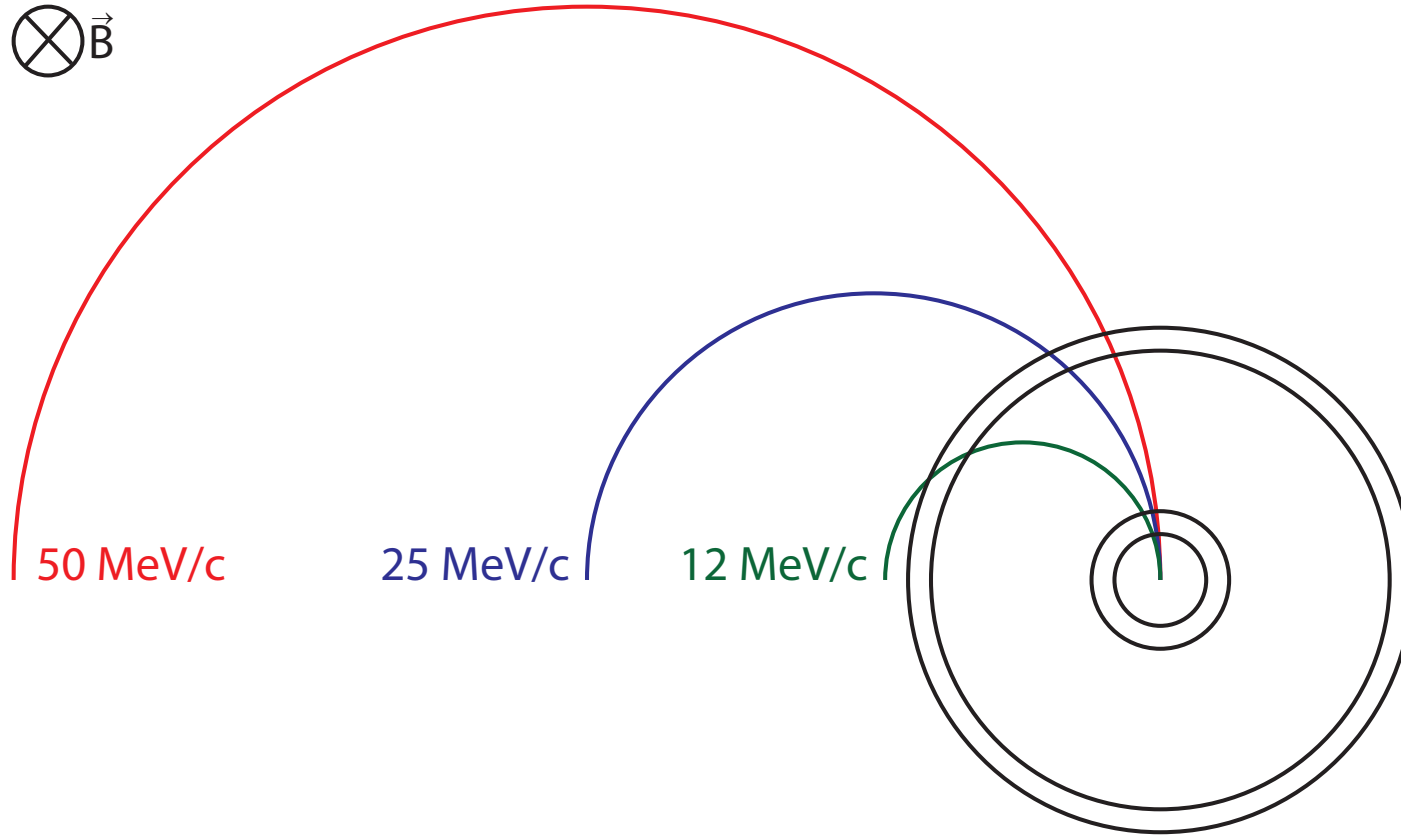


Precision vs. Acceptance

$\otimes \vec{B}$

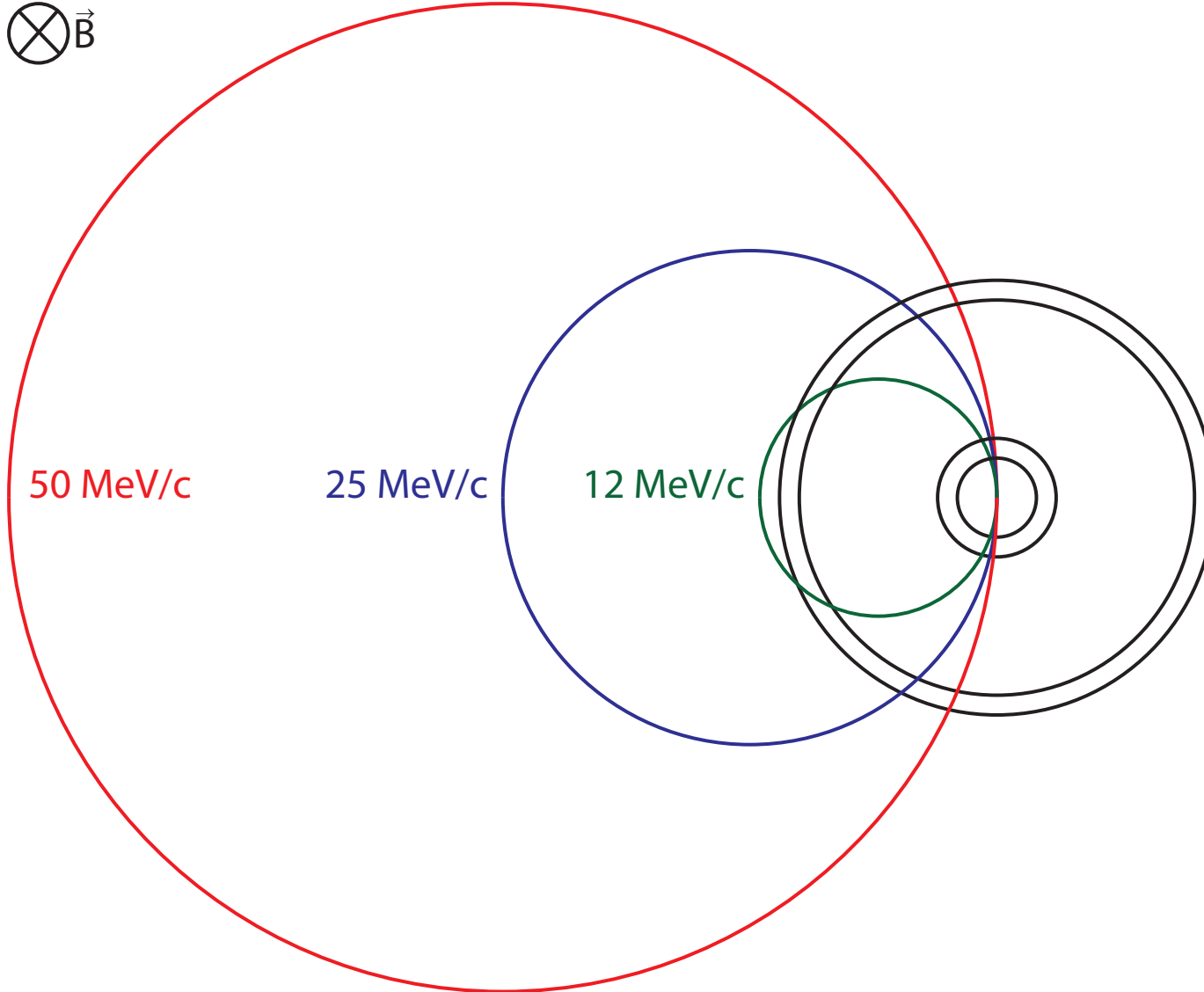


Precision vs. Acceptance

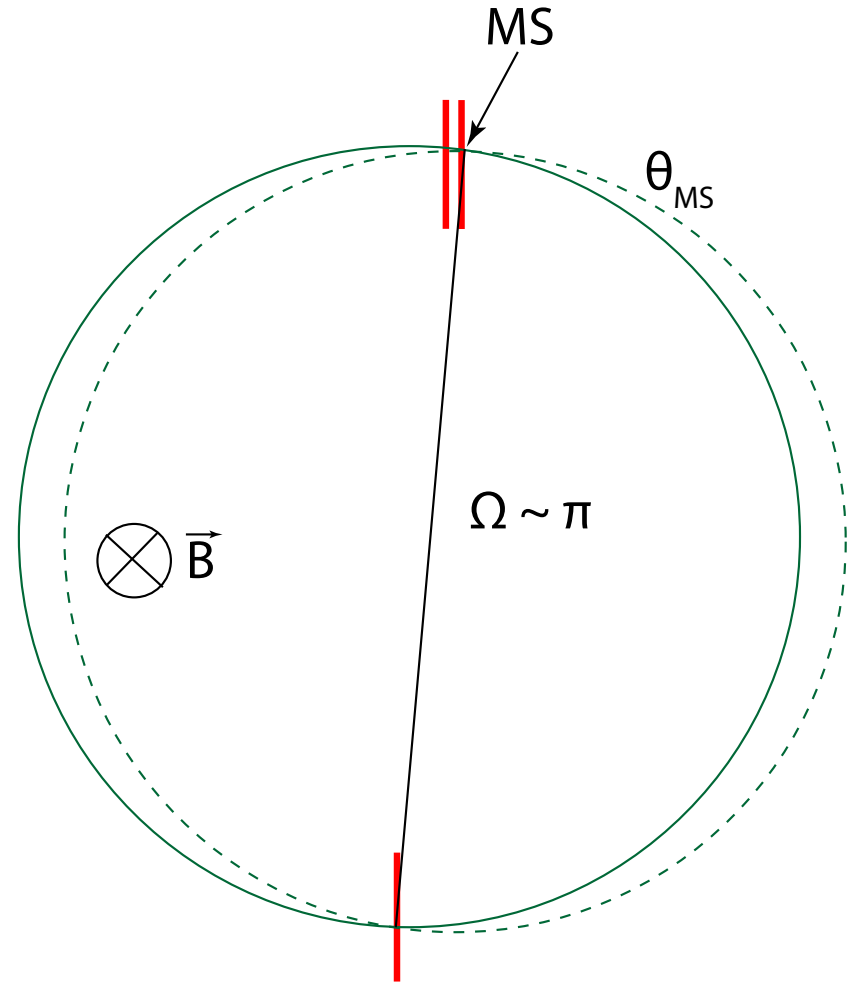
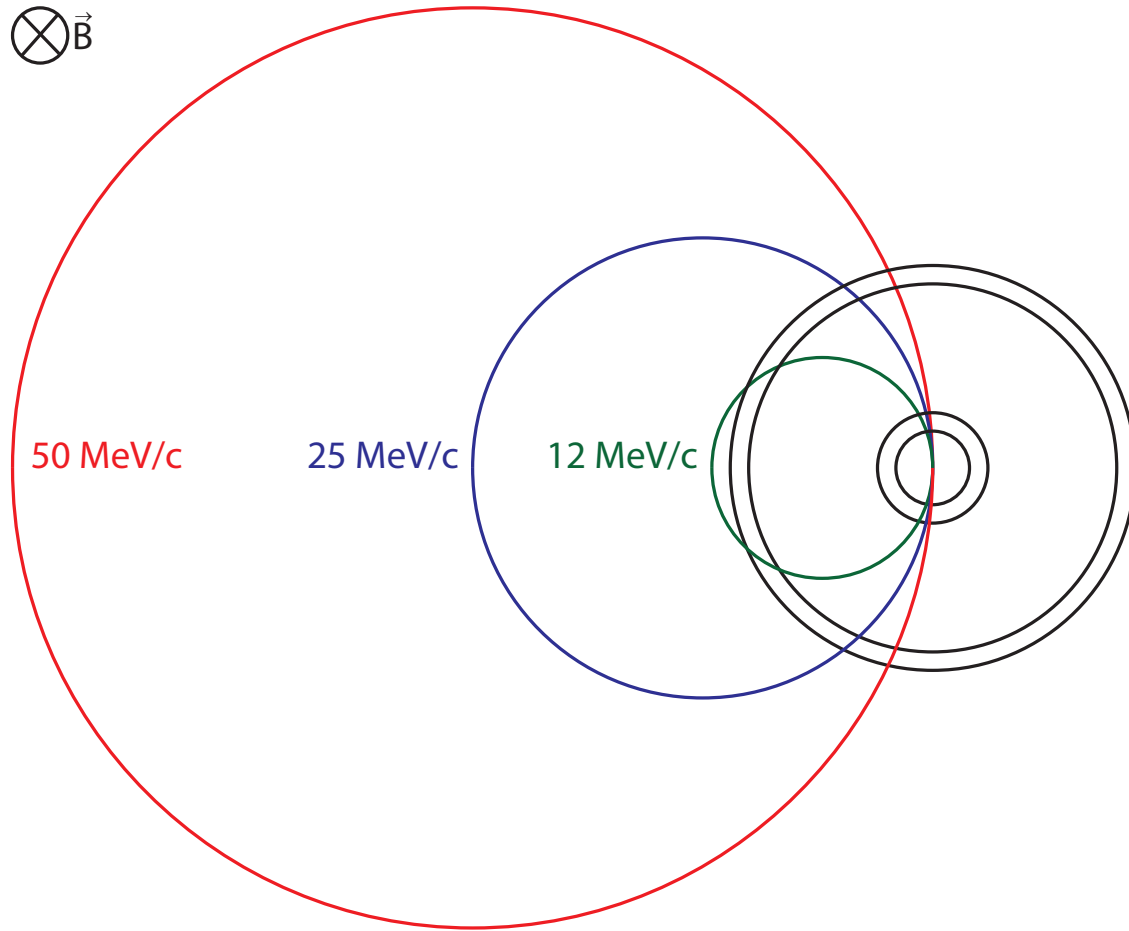




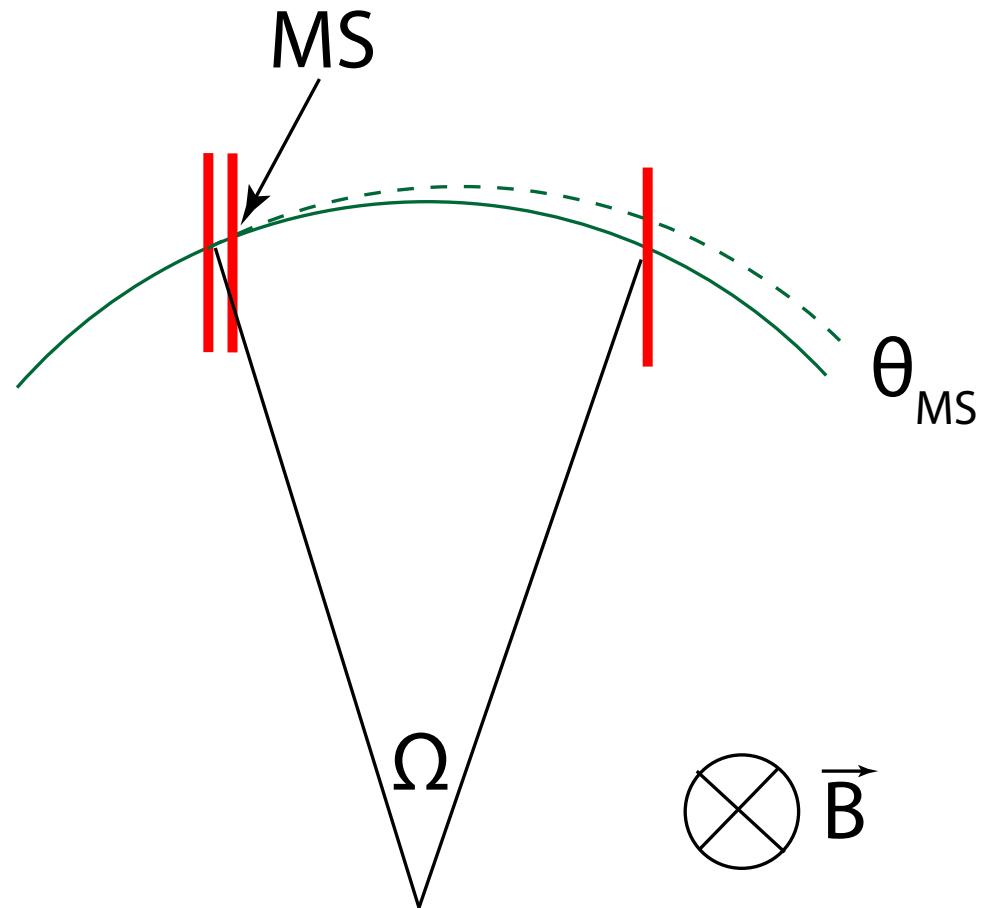
Precision vs. Acceptance



Precision vs. Acceptance



Momentum measurement



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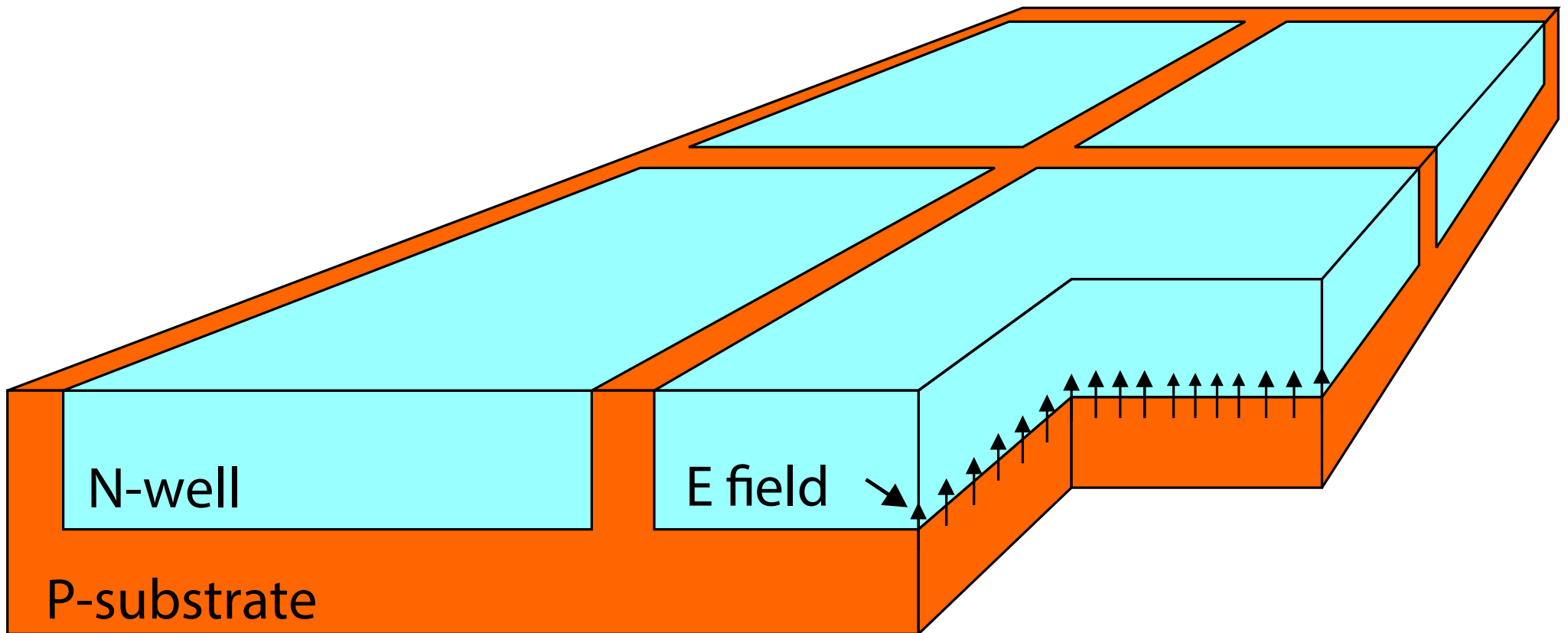
Very thin and fast silicon pixel sensors: HV-MAPS



Fast and thin sensors: HV-MAPS

High voltage monolithic active pixel sensors - Ivan Perić

- Use a high voltage commercial process (automotive industry)

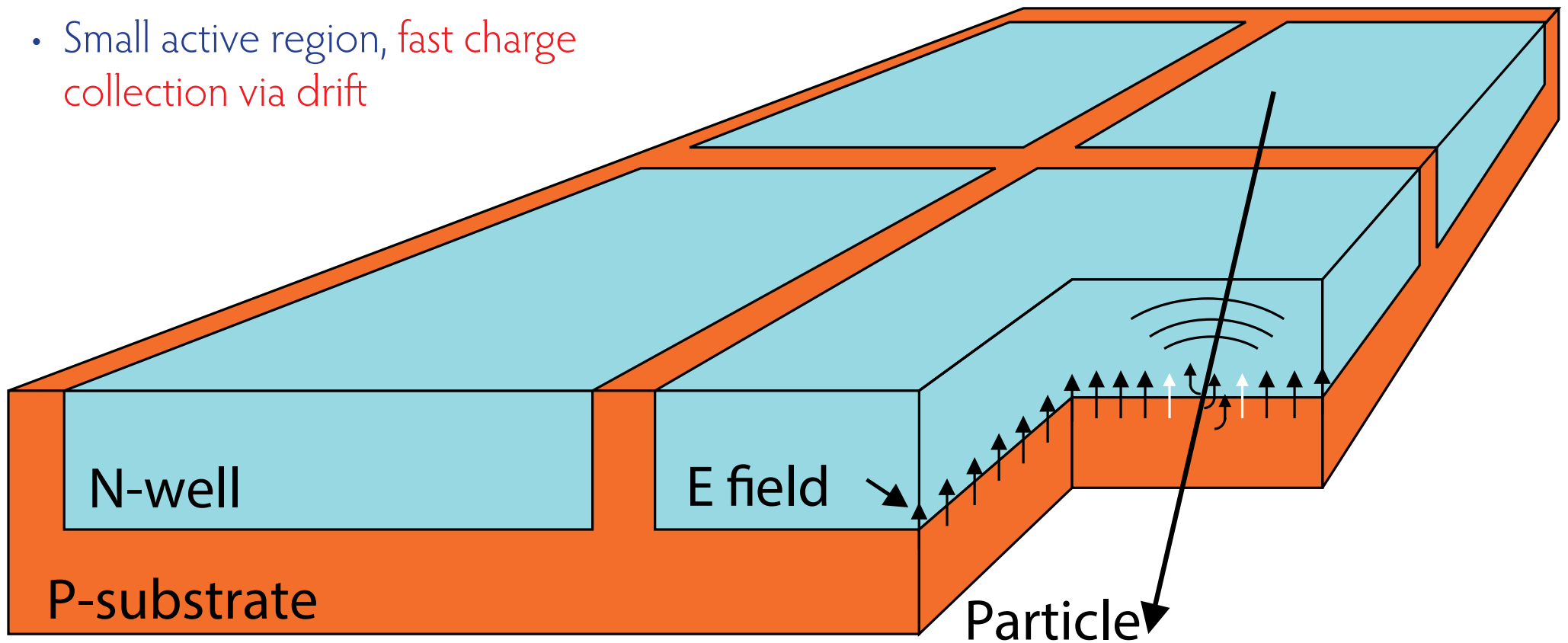




Fast and thin sensors: HV-MAPS

High voltage monolithic active pixel sensors - Ivan Perić

- Use a high voltage commercial process (automotive industry)
- Small active region, fast charge collection via drift





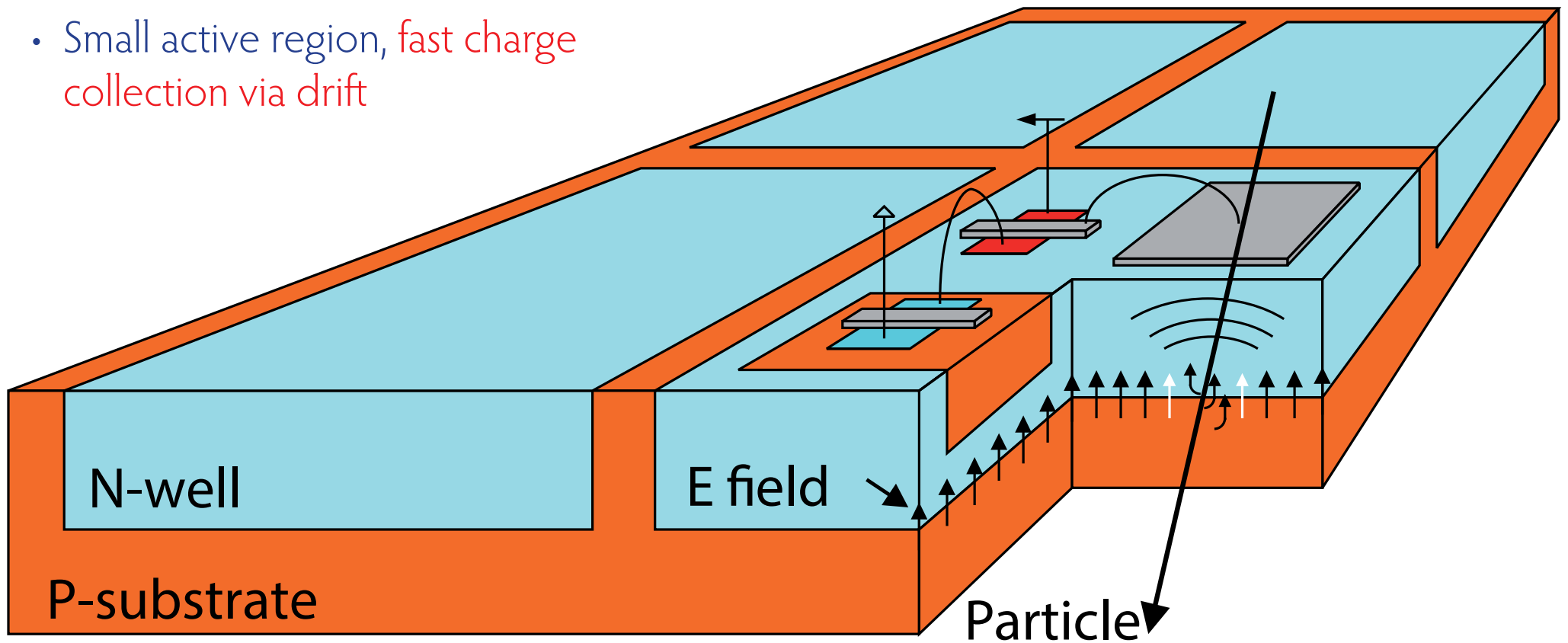
Fast and thin sensors: HV-MAPS

High voltage monolithic active pixel sensors - Ivan Perić

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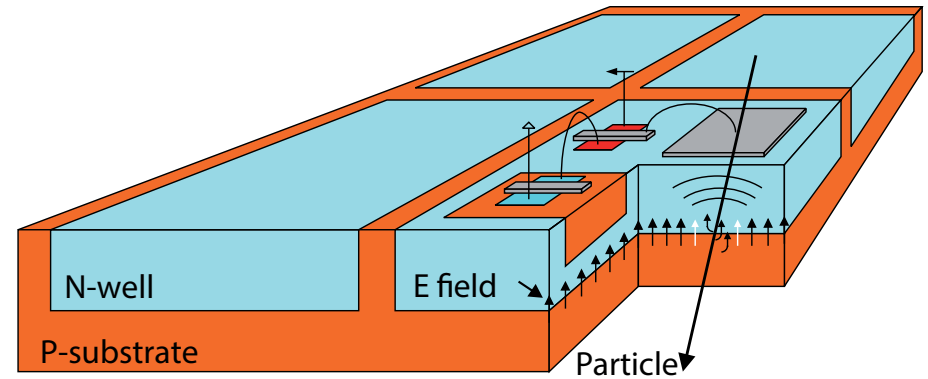
- Implement logic directly in N-well in the pixel - smart diode array
- Can be thinned down to $\sim 50 \mu\text{m}$

(I.Perić, NIM A 582 (2007) 876)

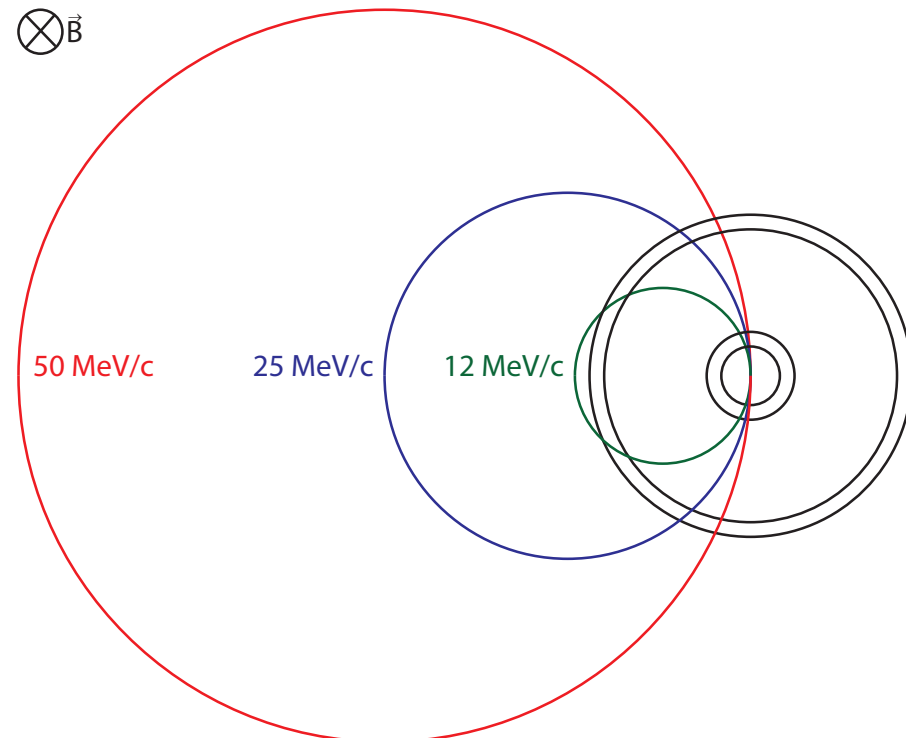


Mu3e concept

- HV-MAPS: Thin, fast pixel sensors

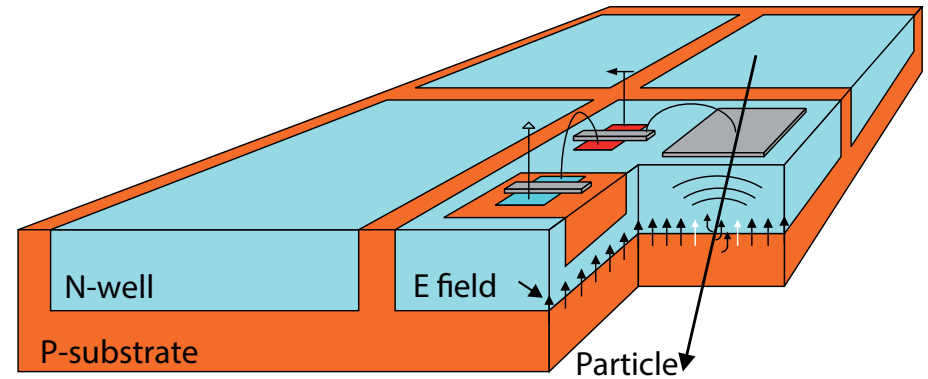


- Recurler tracking: Bending in field happens mainly outside of the tracker



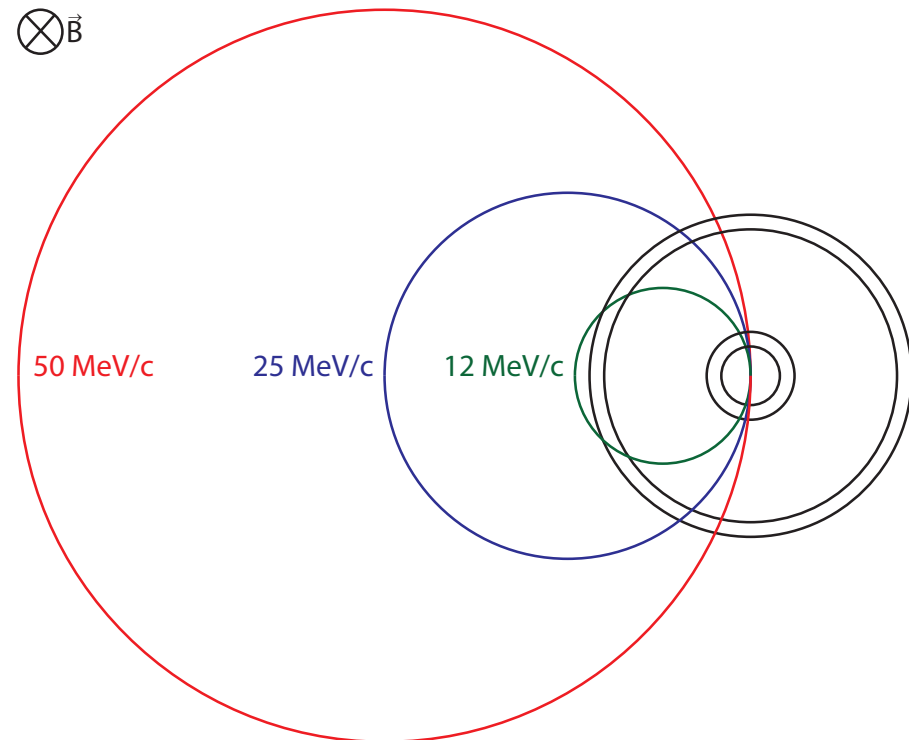
Mu3e concept

- HV-MAPS: Thin, fast pixel sensors



- Recurler tracking: Bending in field happens mainly outside of the tracker

- We knew that more than 10 years ago - experiment is taking shape now - what happened in the meantime?





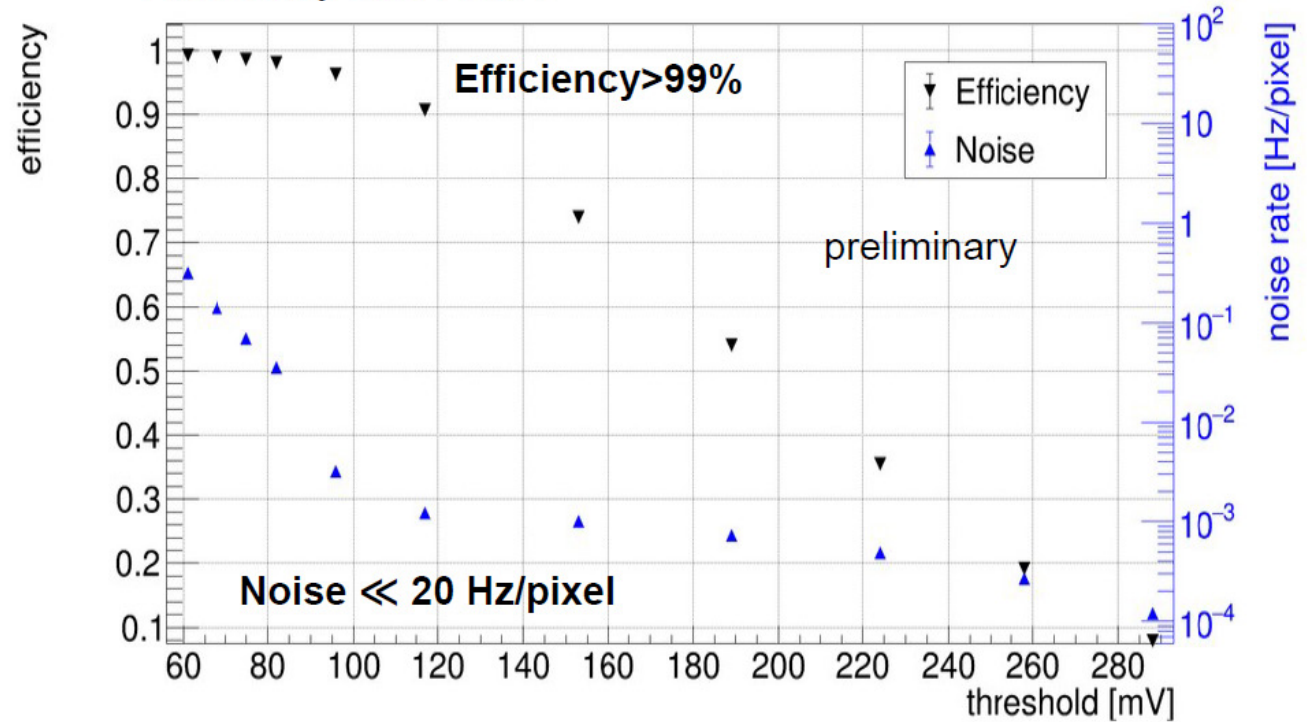
HV-MAPS: Sensor to system

The MuPix chips

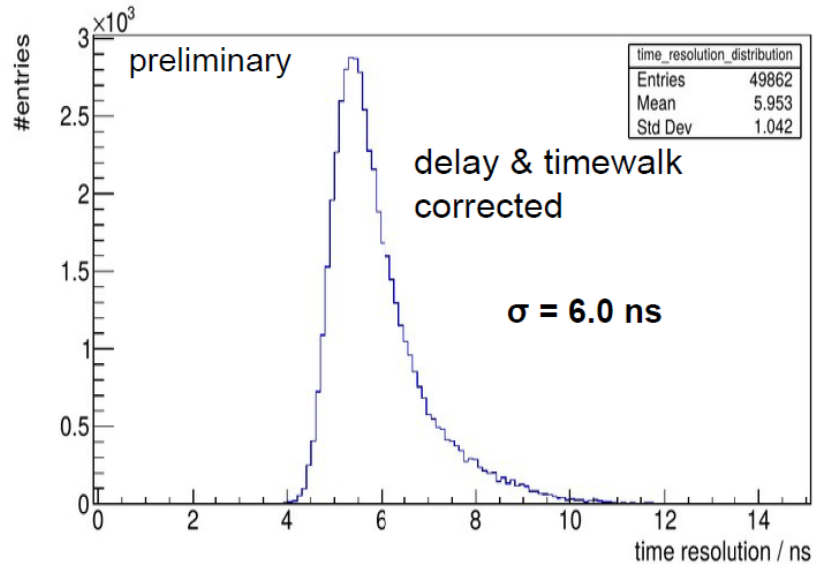
Pixel cell

- 80 x 80 μm^2
- High efficiency
- Low noise
- Good time resolution
- Low power consumption
~ 200 mW/cm² achieved

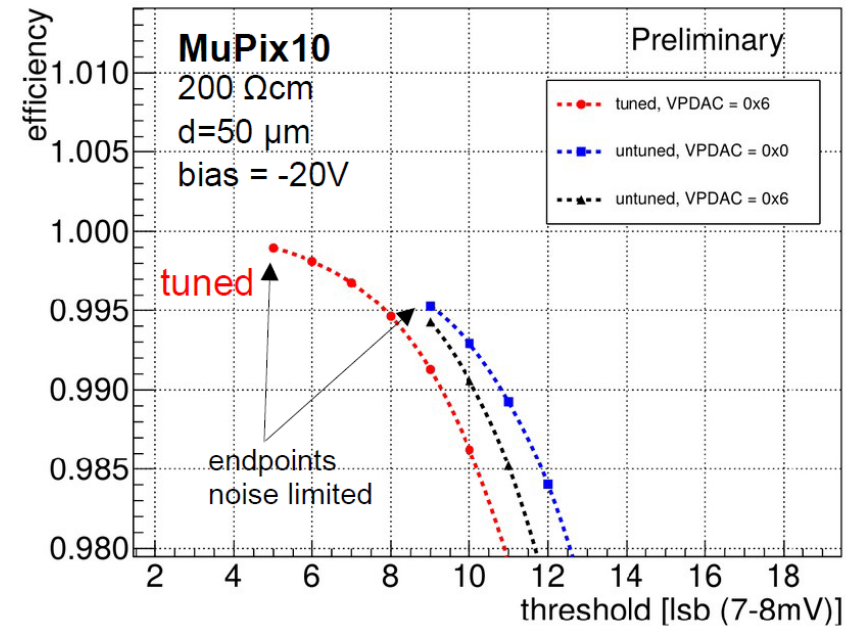
Efficiency and Noise



Time Resolution



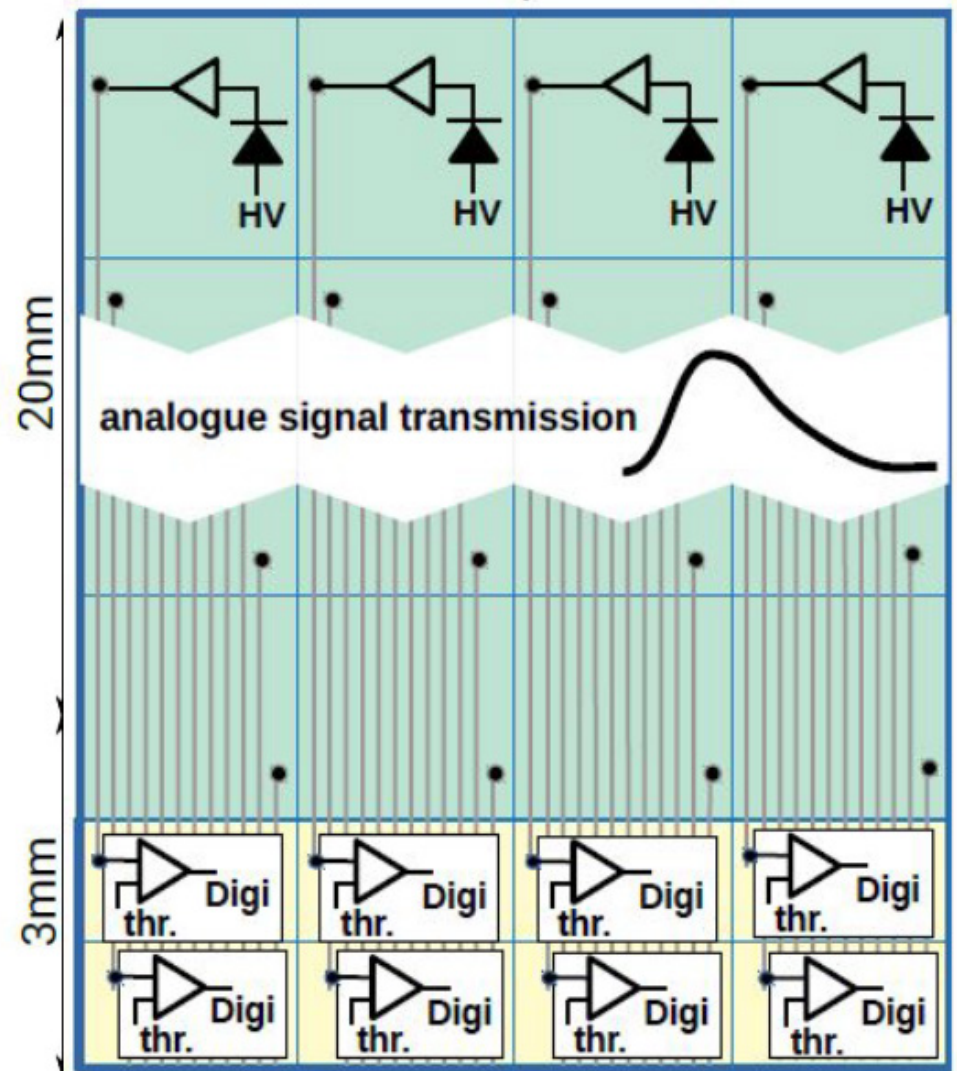
DESY testbeam Dec. 2021





Readout architecture

- Amplifier in pixel
- Comparator, hit latching and time-stamping in the periphery
- Streaming column-drain readout controlled by on-chip state machine
- Three 1.25 Gbit/s LVDS links for data output

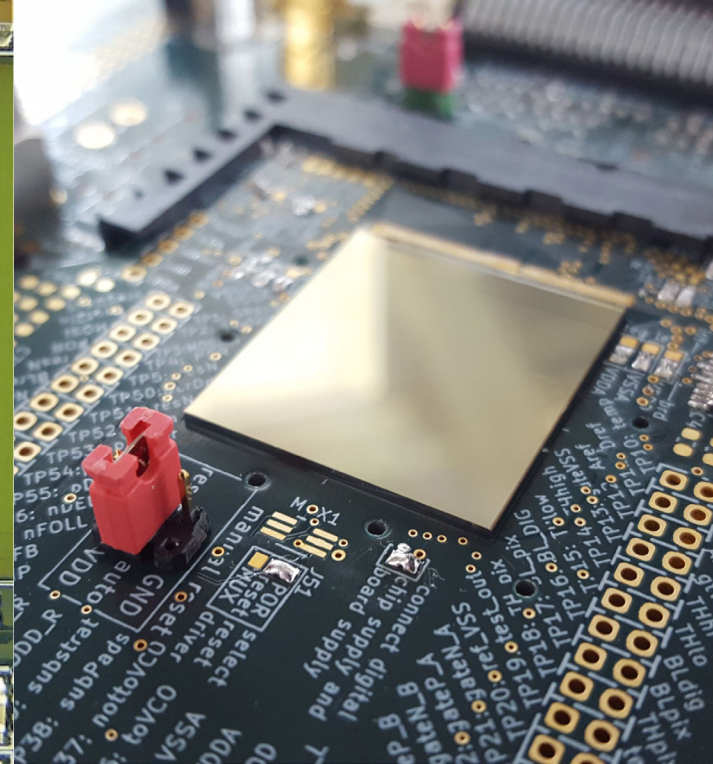
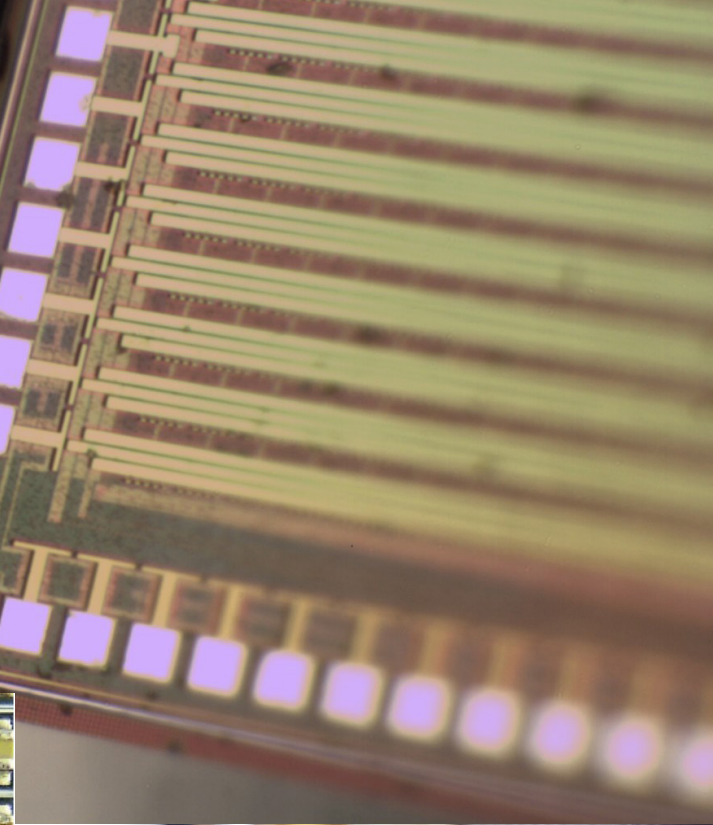


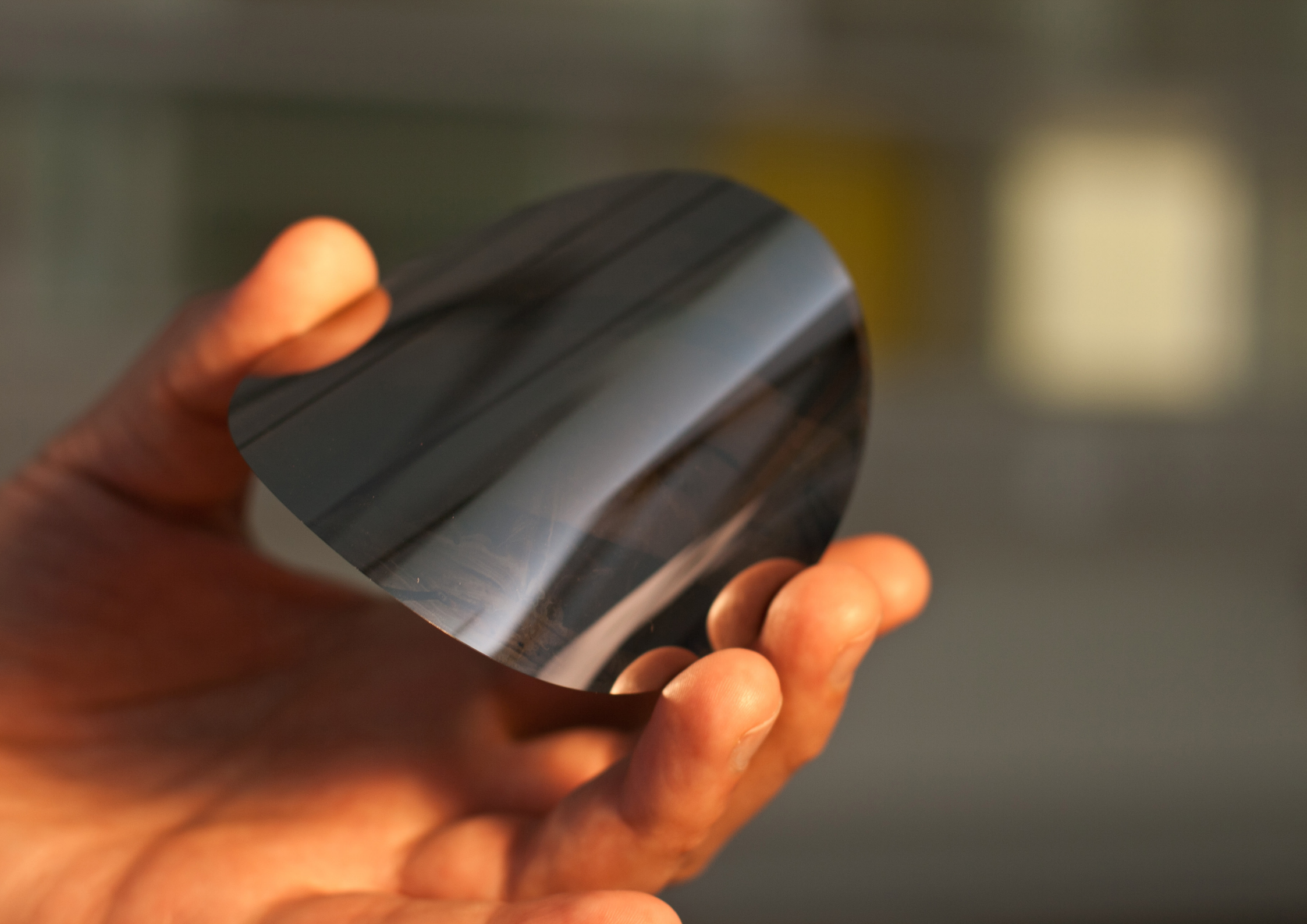


The MuPix Prototypes

Series of HV-MAPS prototypes

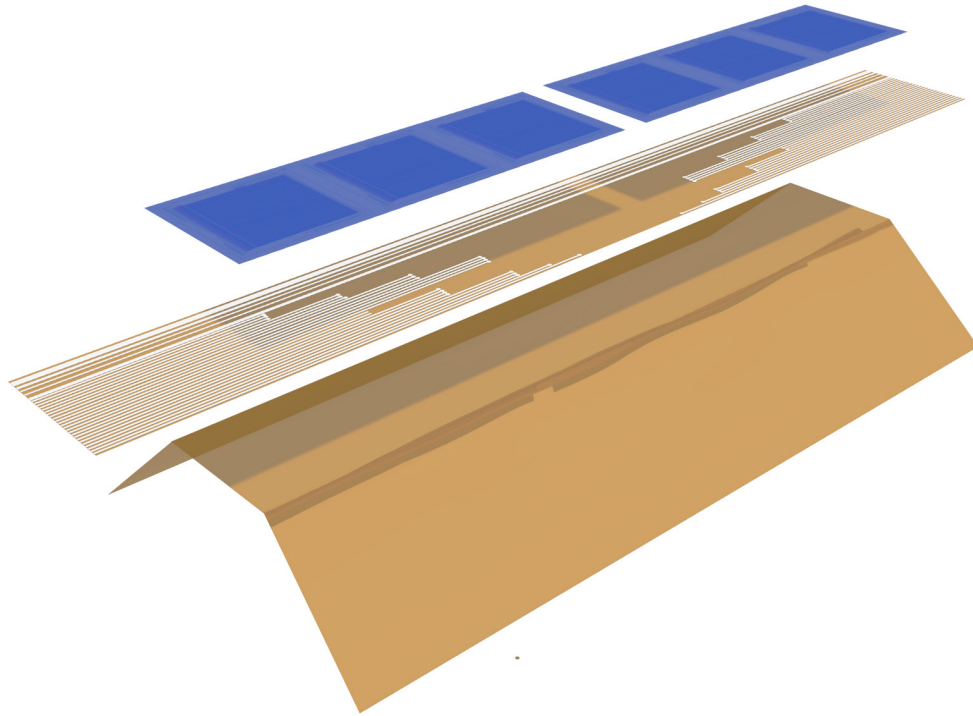
- Goal: Detection and signal processing with just 50 μm silicon
- 6th chip, MuPix7, was the first **full system-on-a-chip**
- **Going "big"** 2 x 1 cm^2 MuPix8 with 80 by 80 μm pixels also working nicely - some growing pains fixed
- **MuPix10**, 2 x 2 cm^2 , almost final
- **MuPix11**, 2 x 2 cm^2 , production chip, now available







Mechanics and Connections

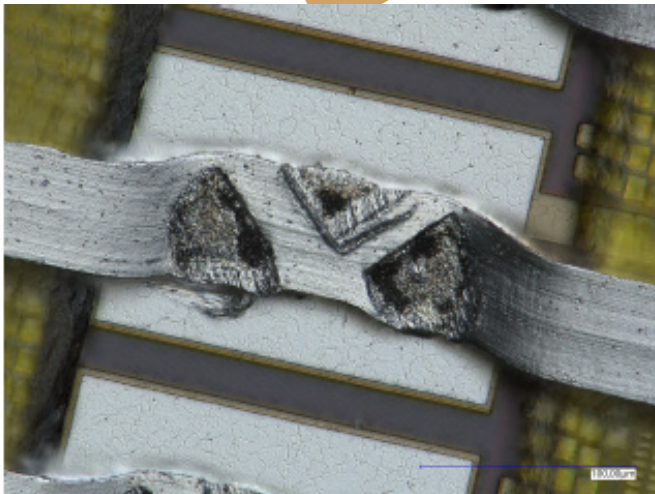
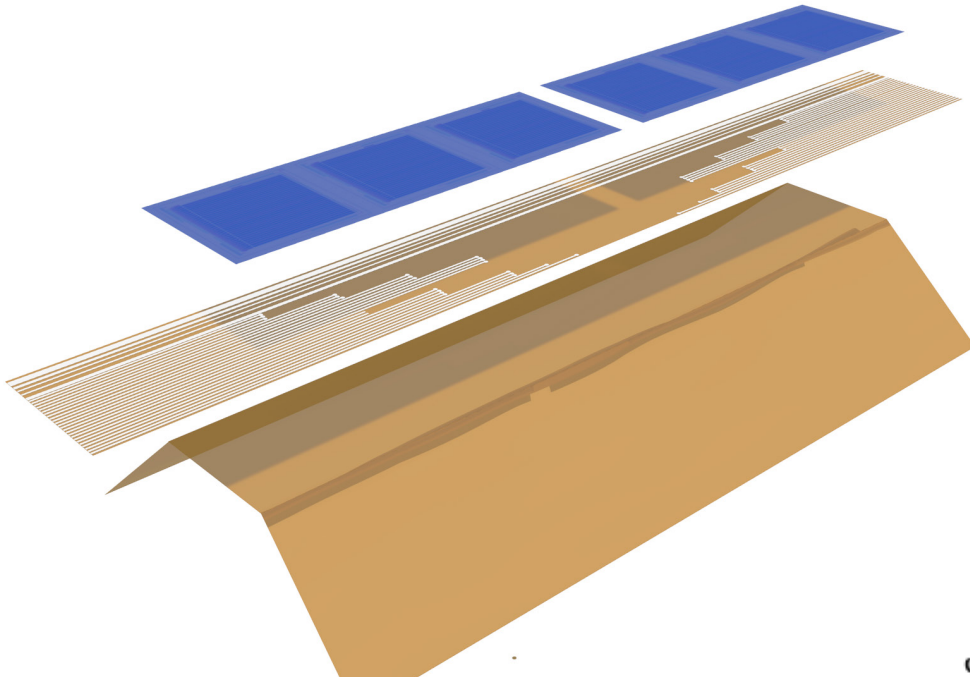


- 50 μm silicon
- 25 μm Kapton™ flexprint with aluminium traces
- Kapton™ or unidirectional carbon fibre supports

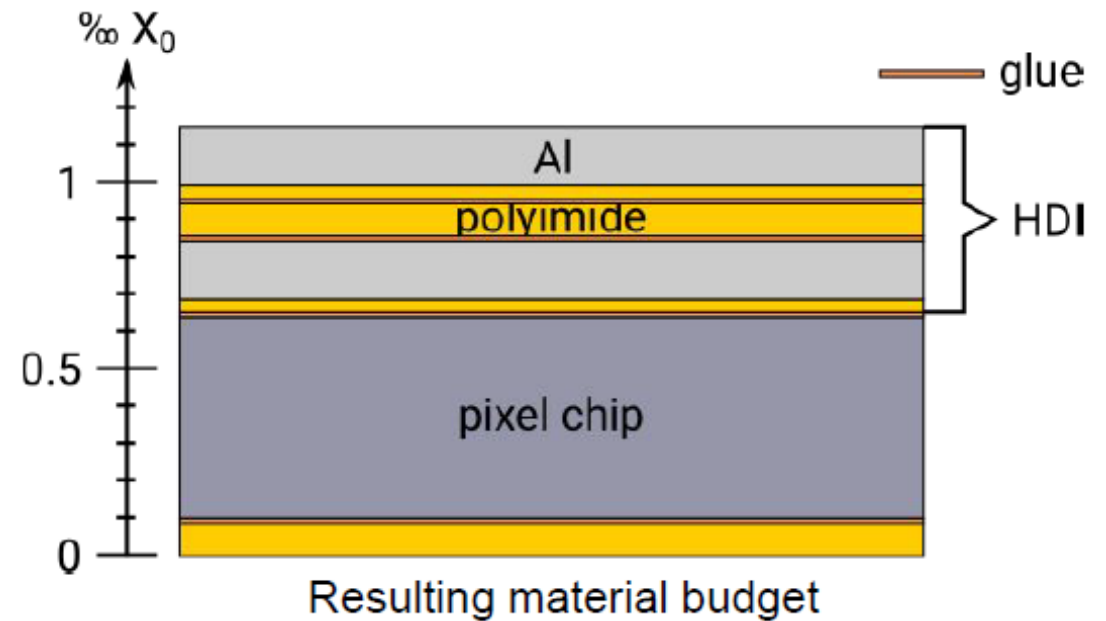


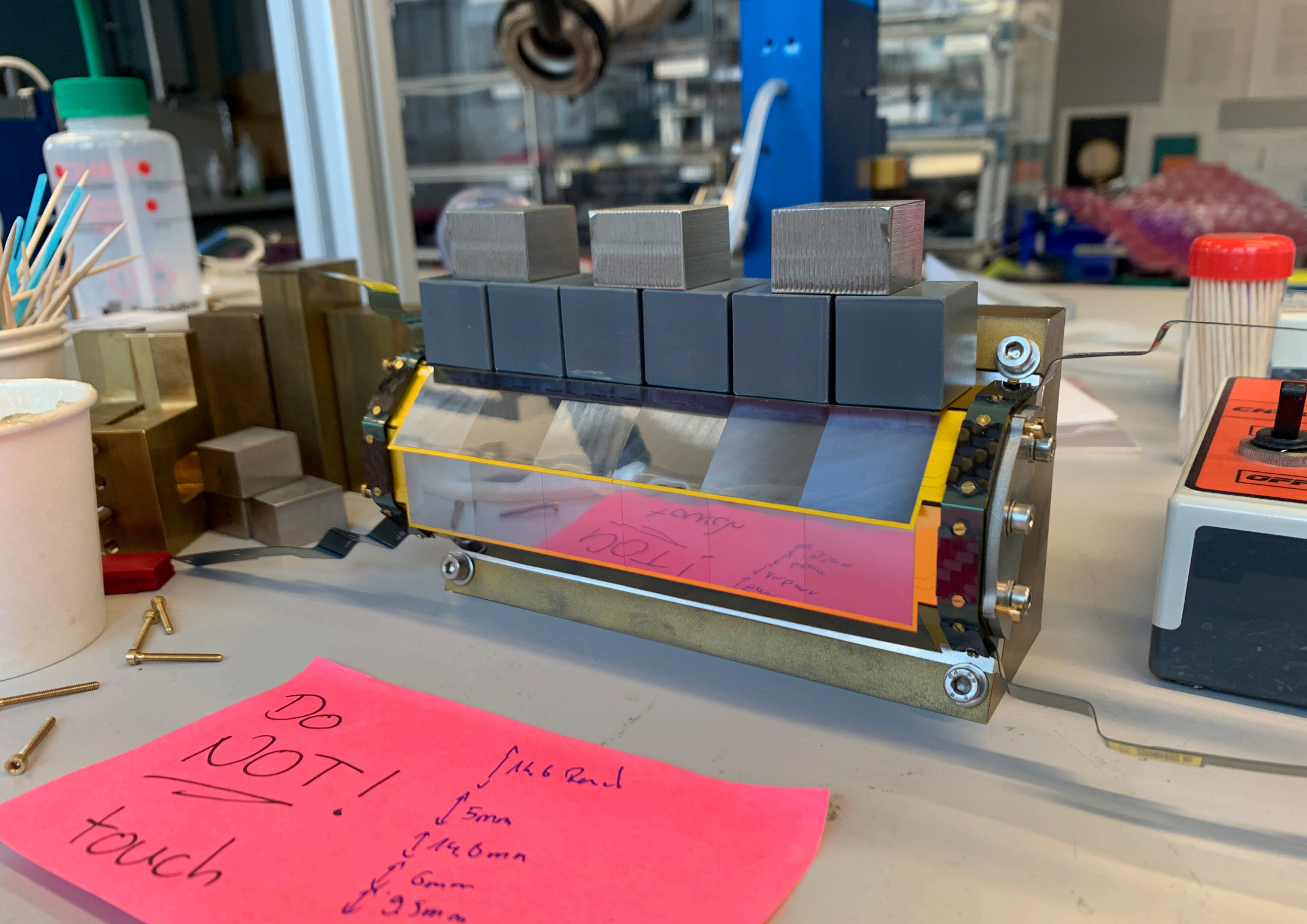
Mechanics and Connections

- 50 μm silicon
- 25 μm Kapton™ flexprint with aluminium traces
- Kapton™ or unidirectional carbon fibre supports
- About 1% of a radiation length per layer
- Large traces: few lines possible
- No decoupling capacitors...



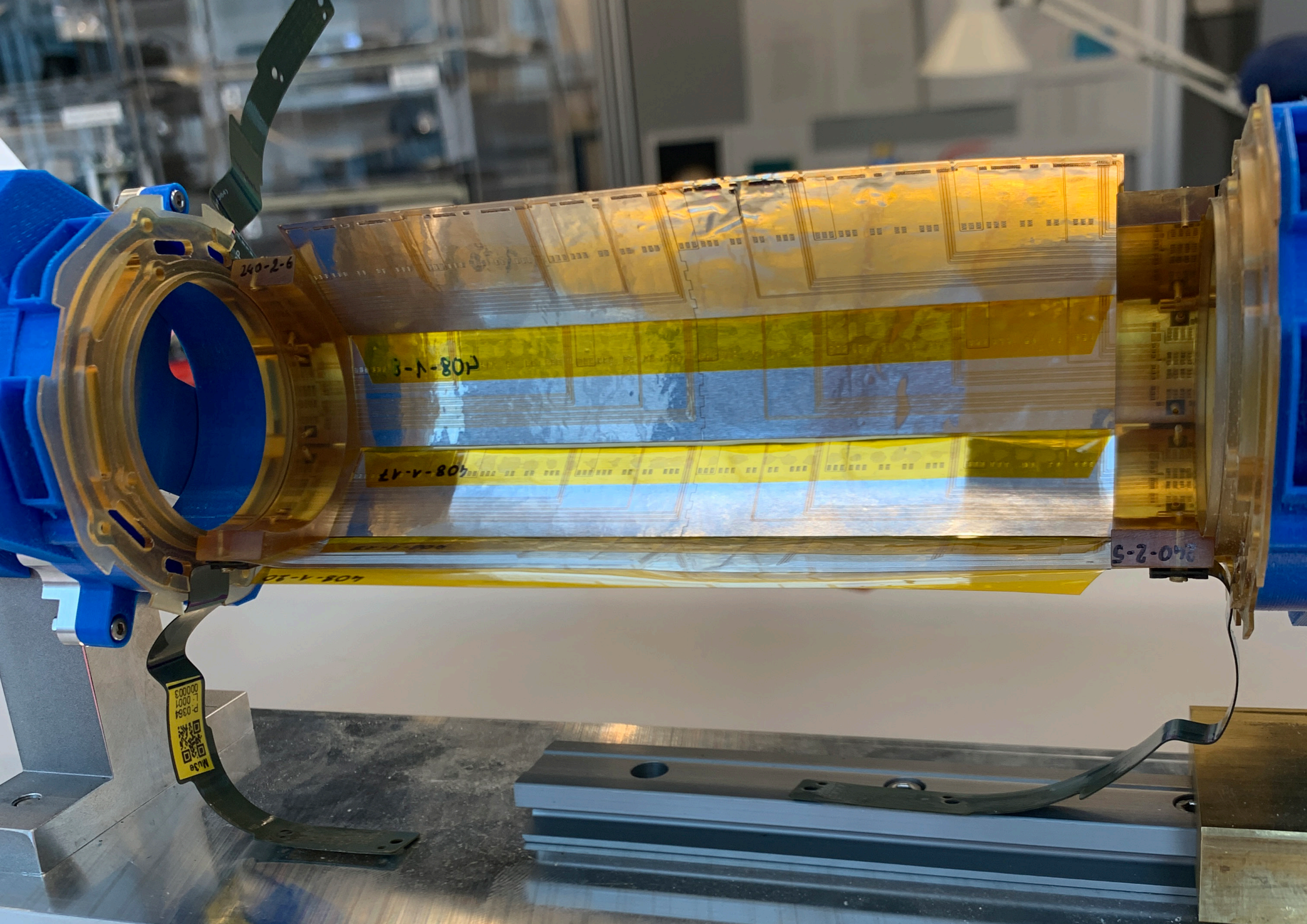
spTAB connection





DO NOT TOUCH
1 TOG
1.5mm
1.5mm
1.5mm
1.5mm

DO NOT touch
14.6 Round
5mm
14.6mm
6mm
2.5mm



240-2-6

408-1-80

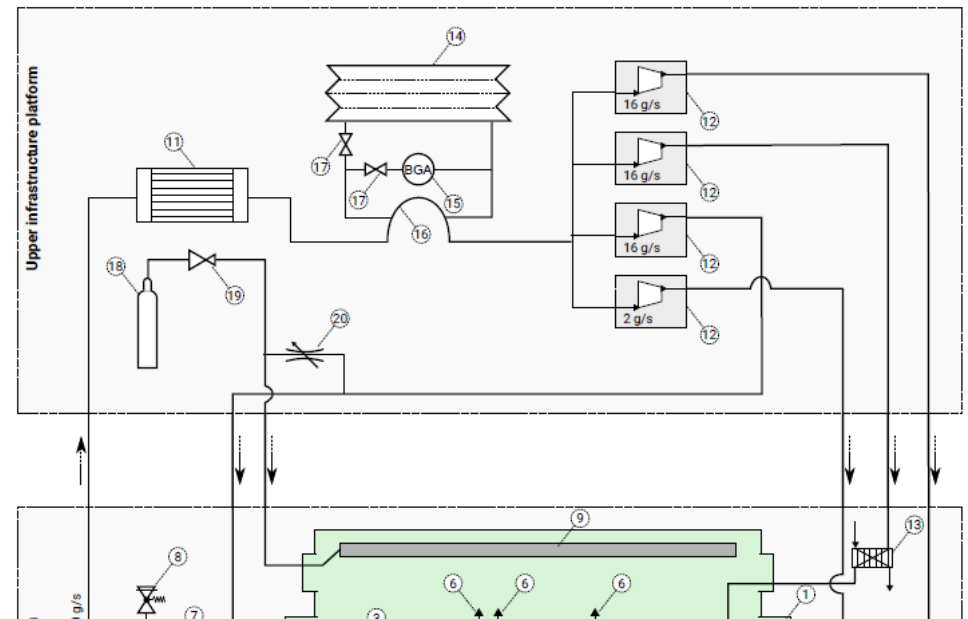
408-1-47

240-2-5

M3e
QR Code
P-0394
L-0001
000003

Cooling

- $\sim 200 \text{ mW/cm}^2$ - about 2 KW for the complete pixel detector
- Add as little material as possible:
Gaseous helium at $\sim 0^\circ\text{C}$
- Need around 50 g/s
($\sim 280 \text{ liter/s}$ at STP...)
- Helium is difficult to pump...
- Very nice little turbocompressors available
- Cooling plant is an engineering project of its own



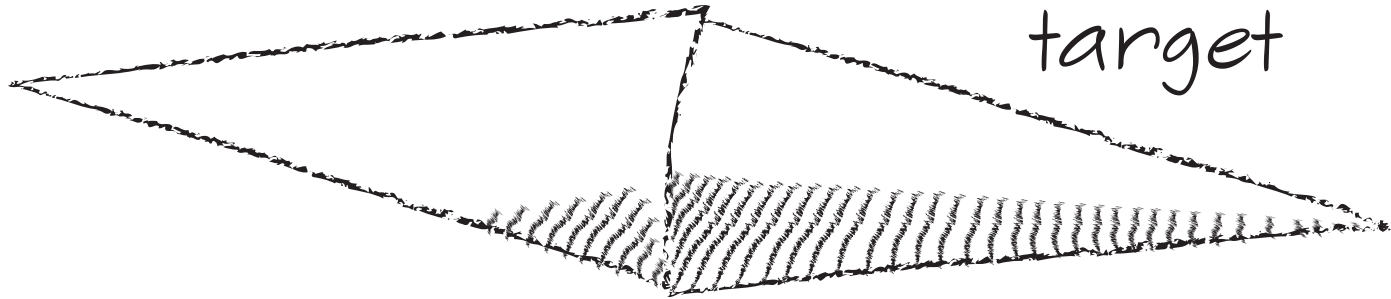
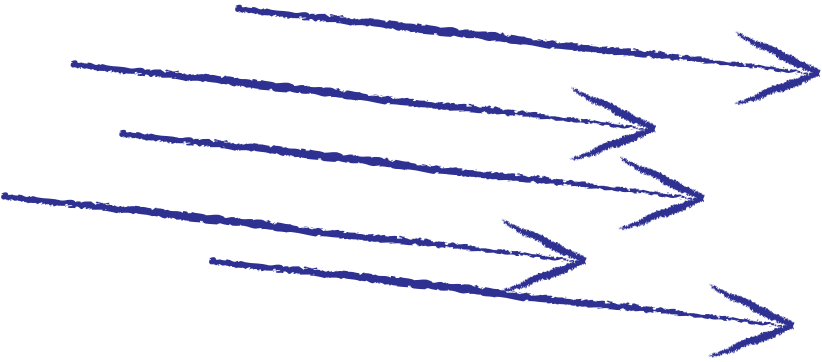


Assemble this to an experiment...



Detector Design

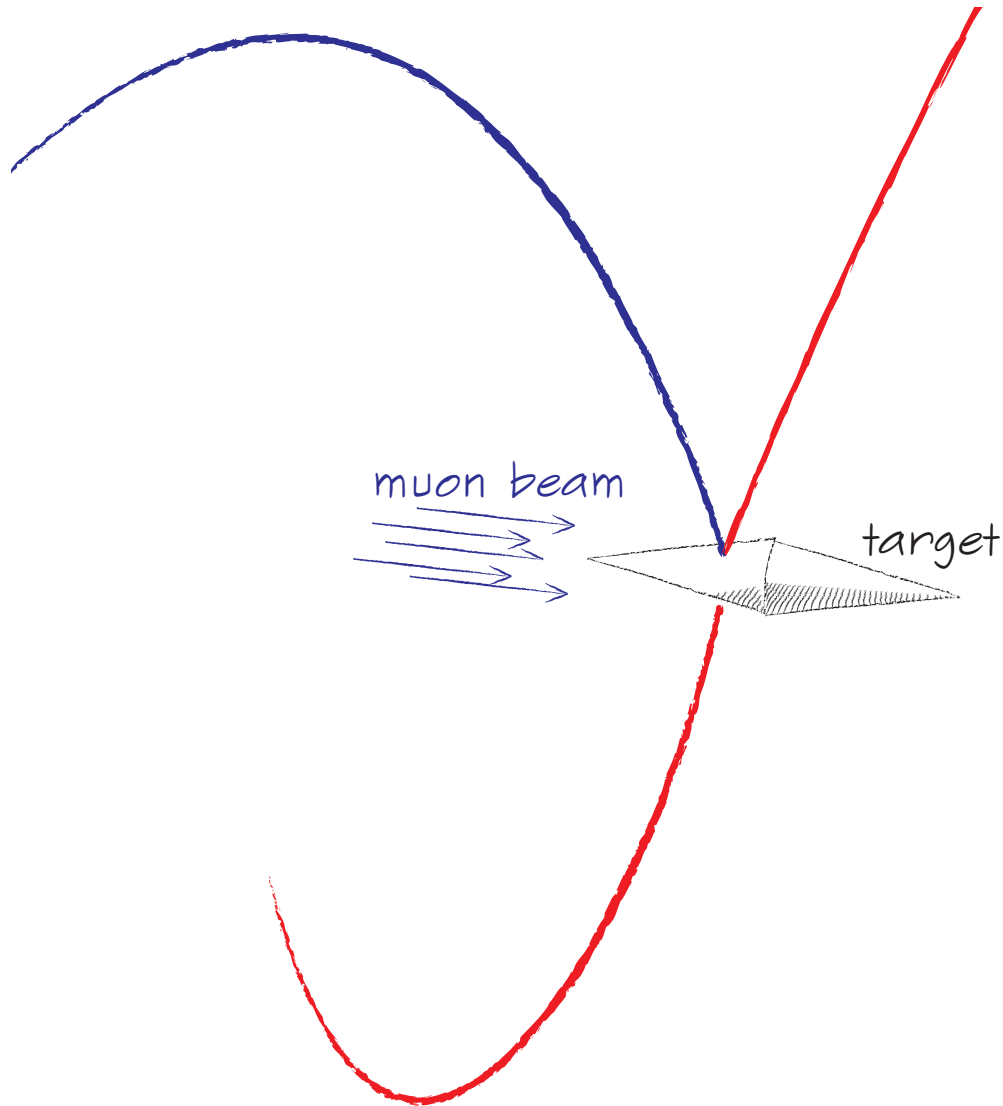
muon beam



target

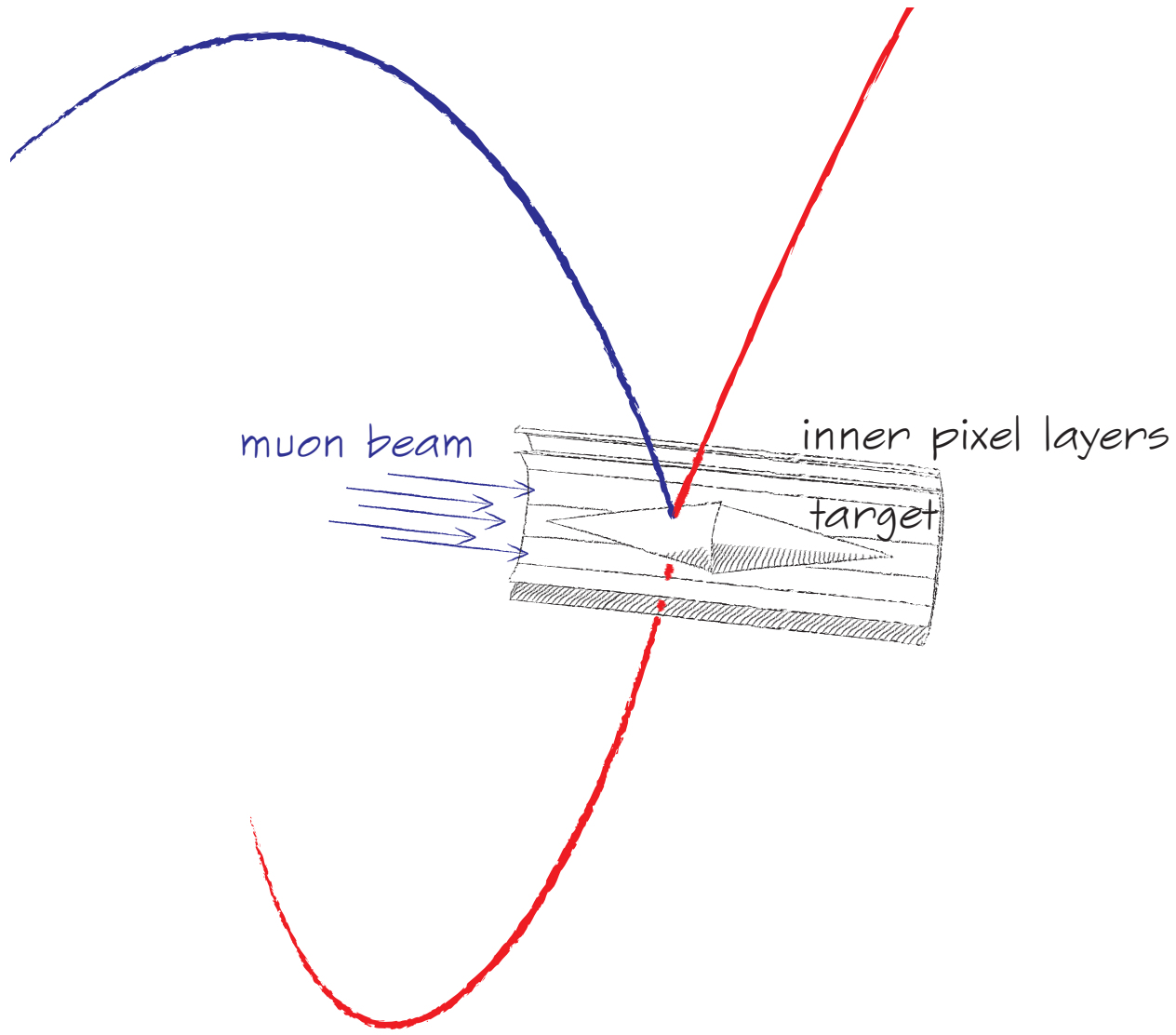


Detector Design



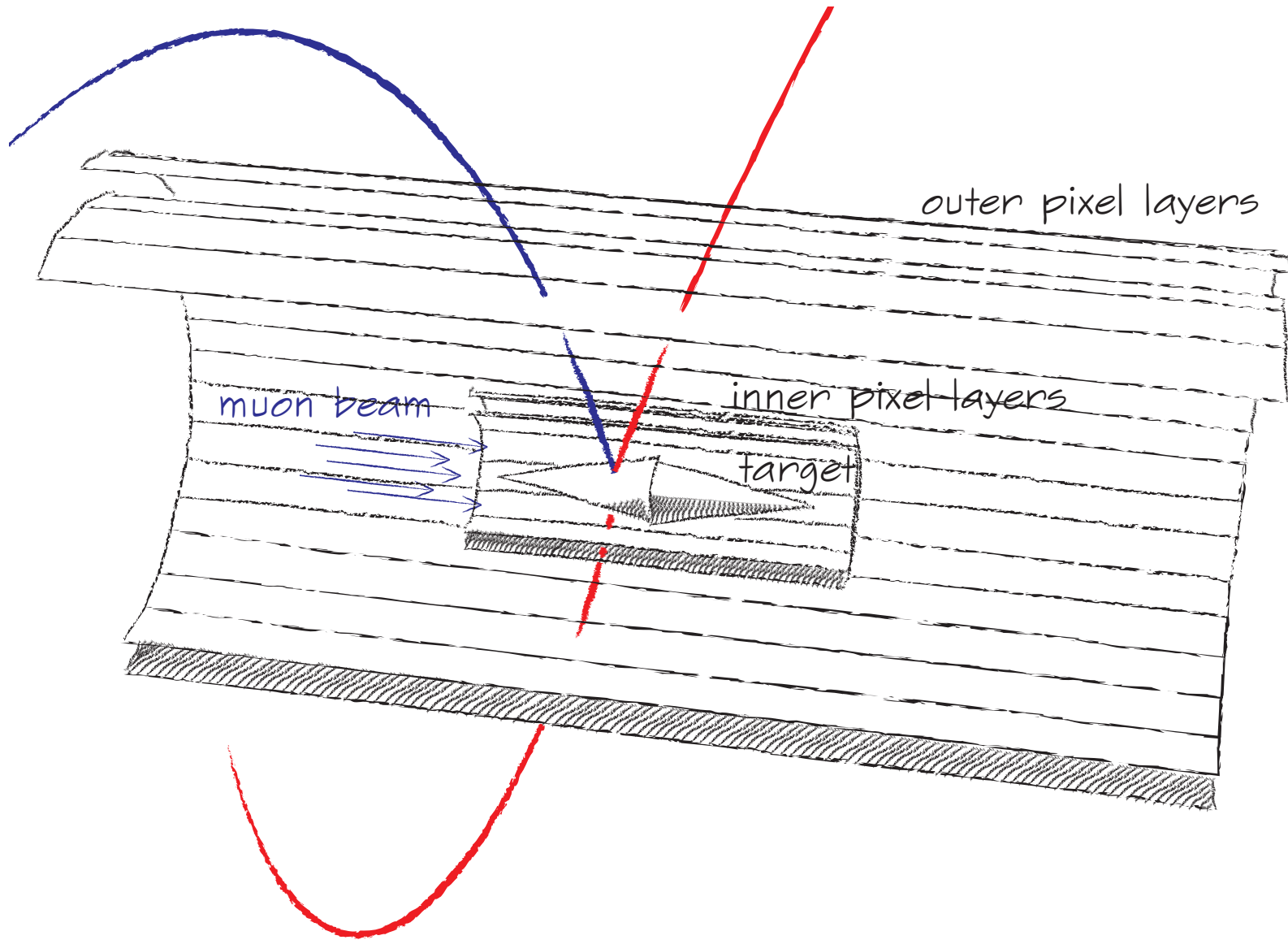


Detector Design



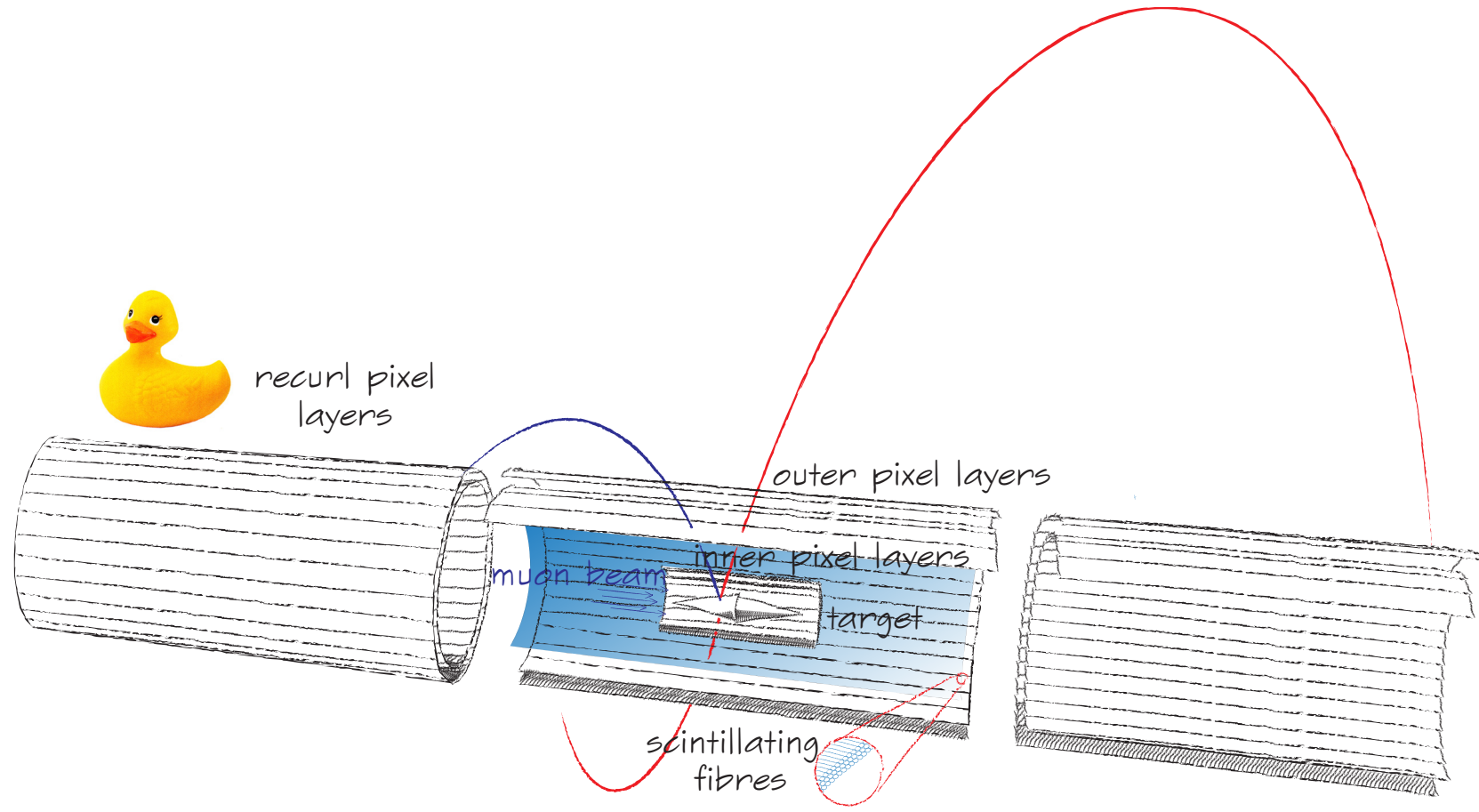


Detector Design





Detector Design



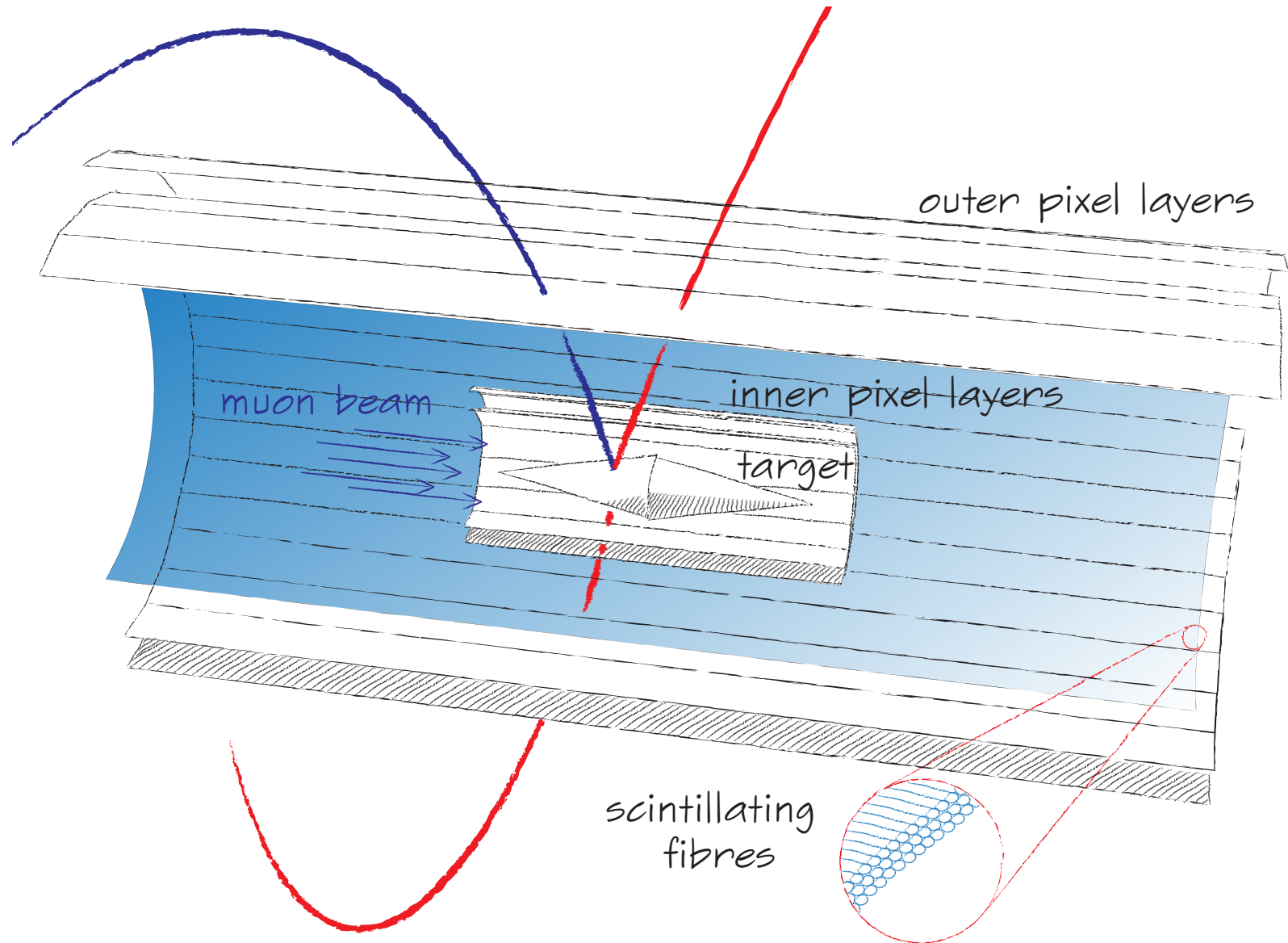


Need further suppression of accidental background:

Timing

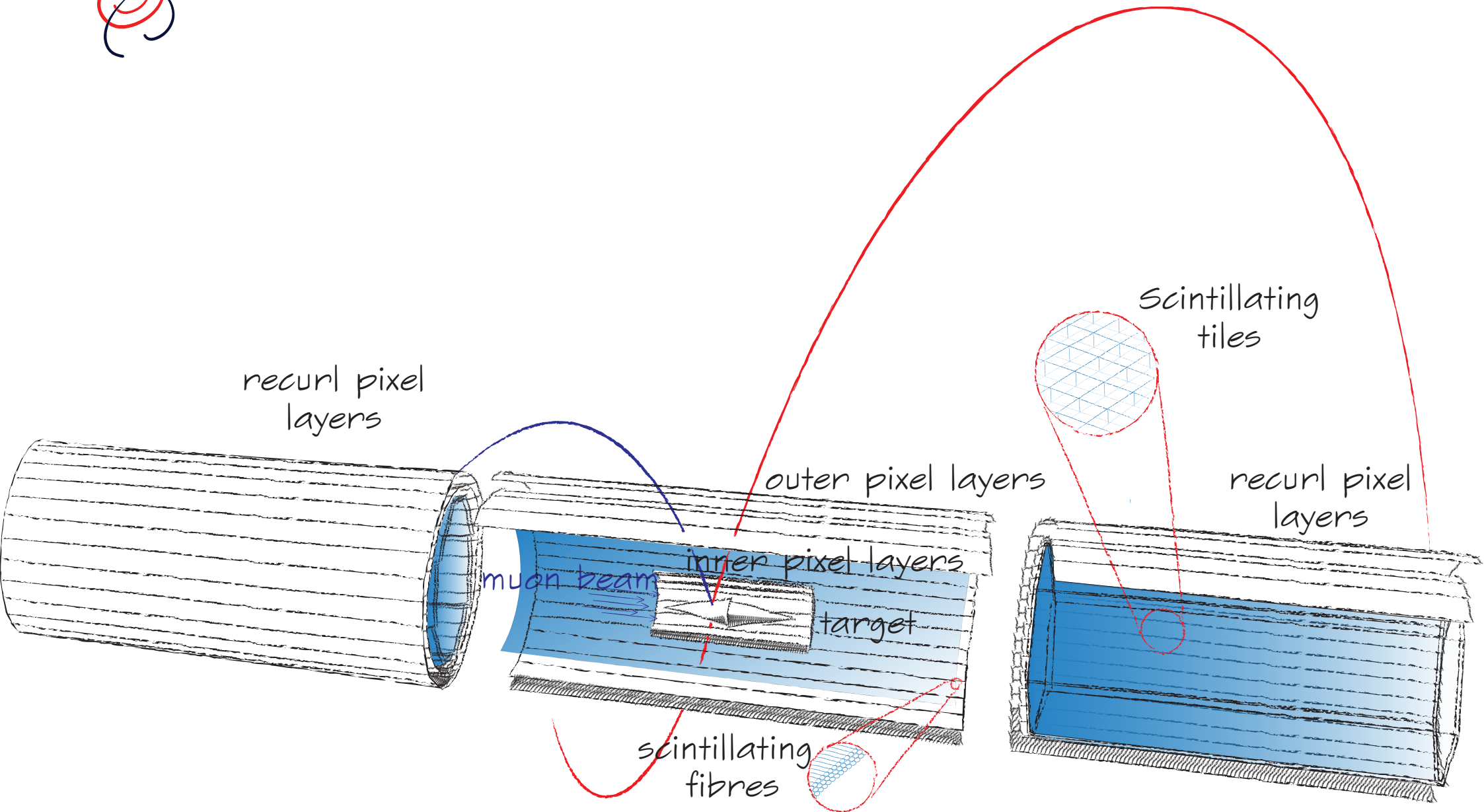


Detector Design





Detector Design

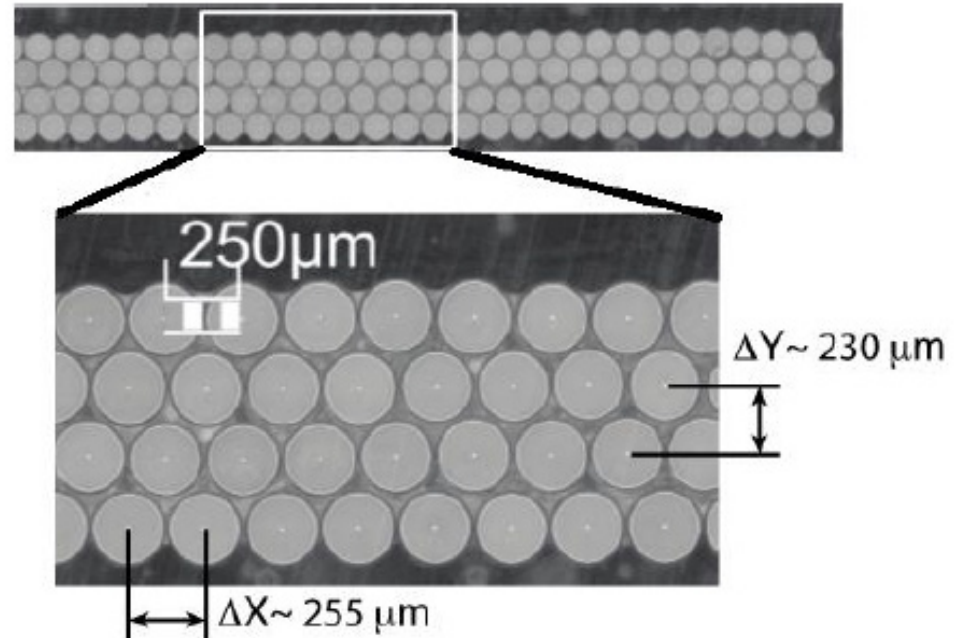
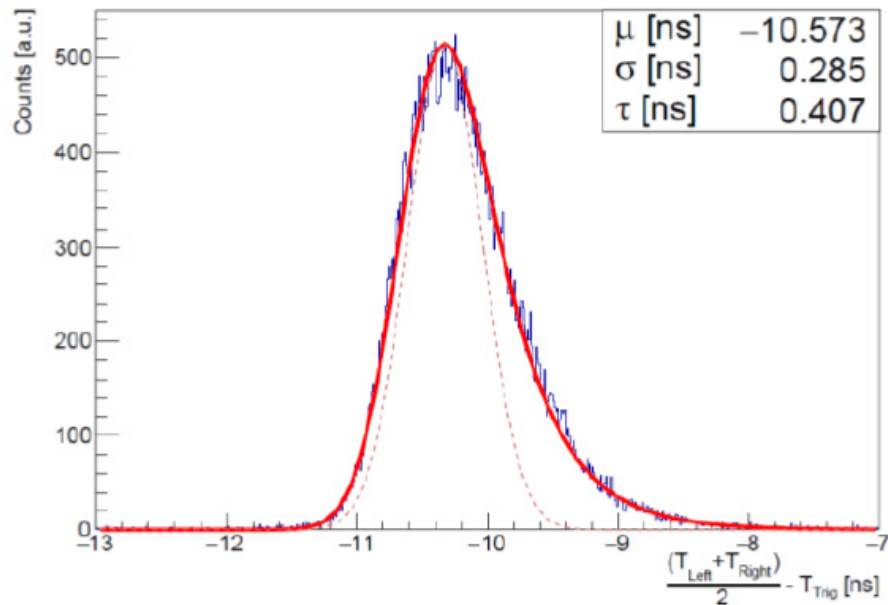




Timing Detector: Scintillating Fibres

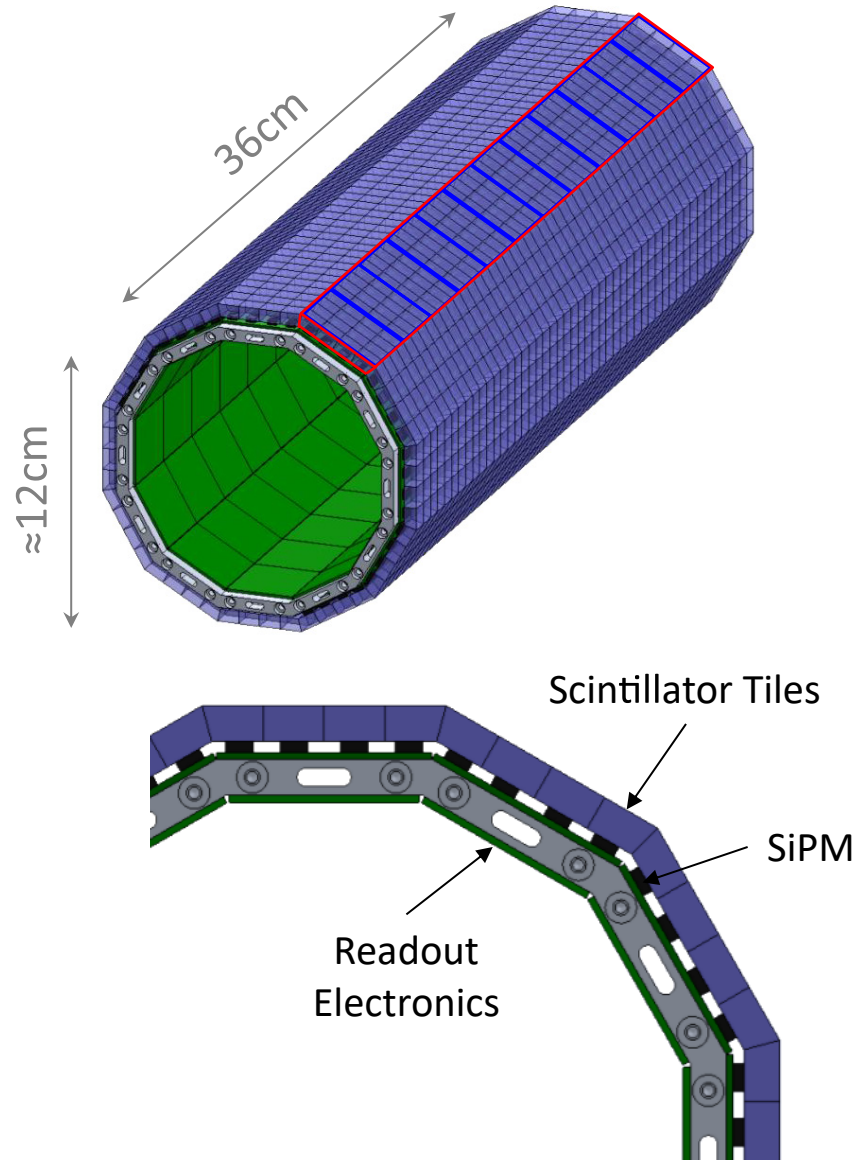


- 3 layers of 250 μm scintillating fibres
- Read-out by silicon photomultipliers (SiPMs) and custom ASIC (MuTRiG)
- Timing resolution < 0.5 ns

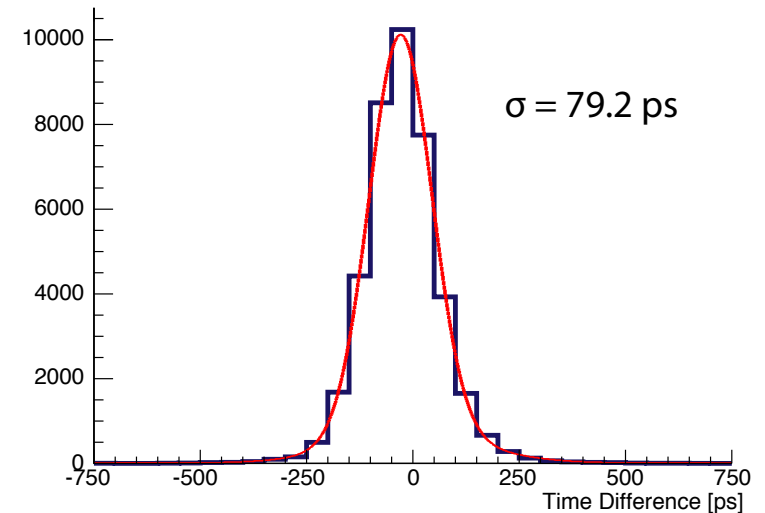




Timing Detector: Scintillating tiles



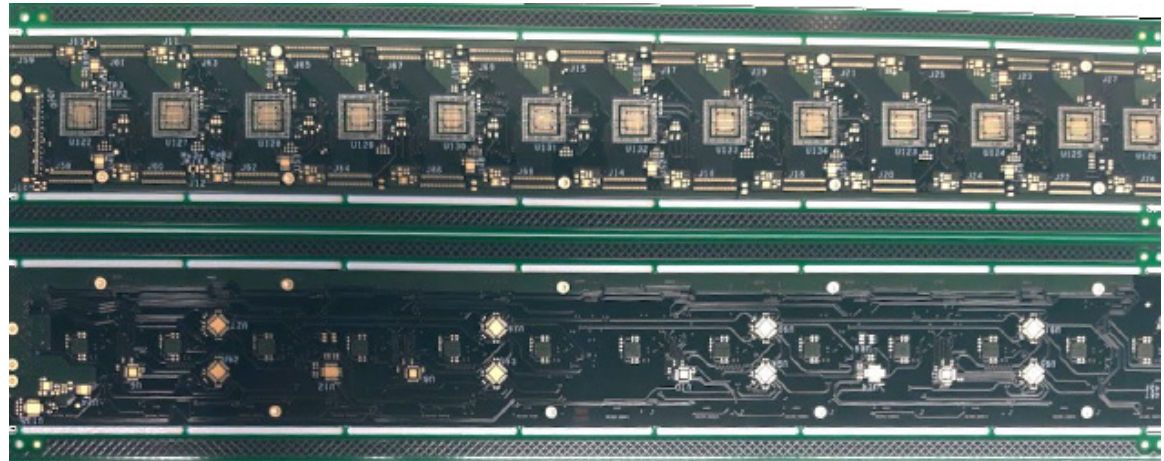
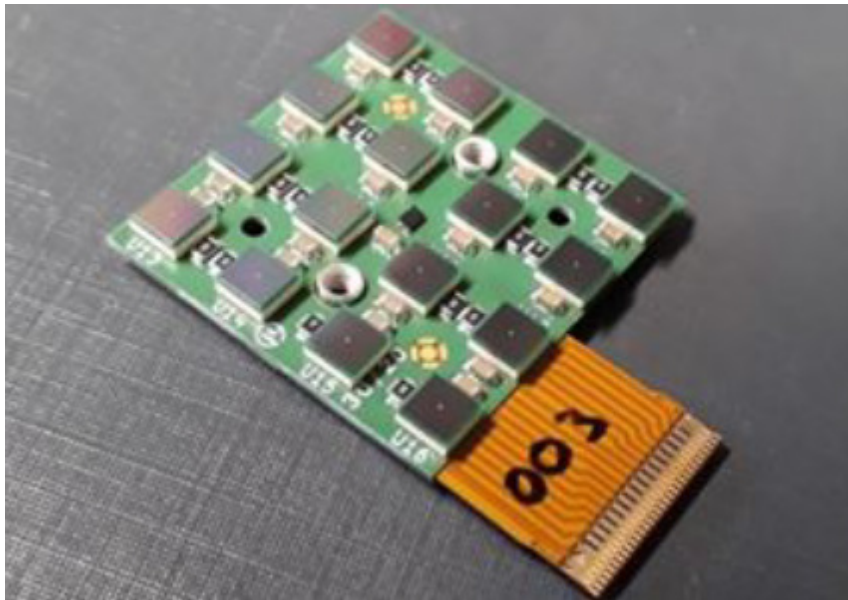
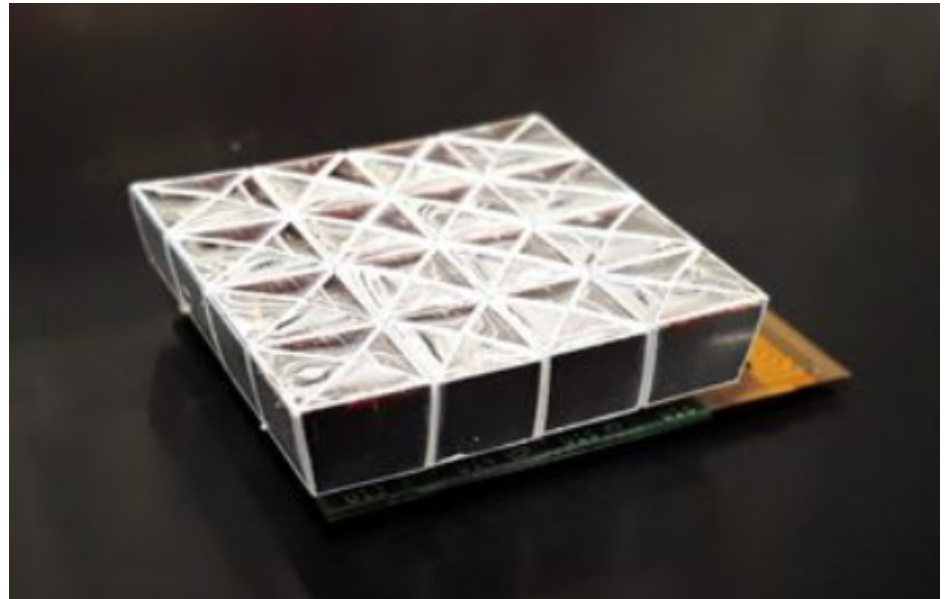
- $\sim 0.5 \text{ cm}^3$ scintillating tiles
- Read-out by silicon photomultipliers (SiPMs) and custom ASIC (STiC)



- Test beam with tiles, SiPMs and readout ASIC
- Timing resolution $\sim 80 \text{ ps}$



Timing Detector: Scintillating tiles

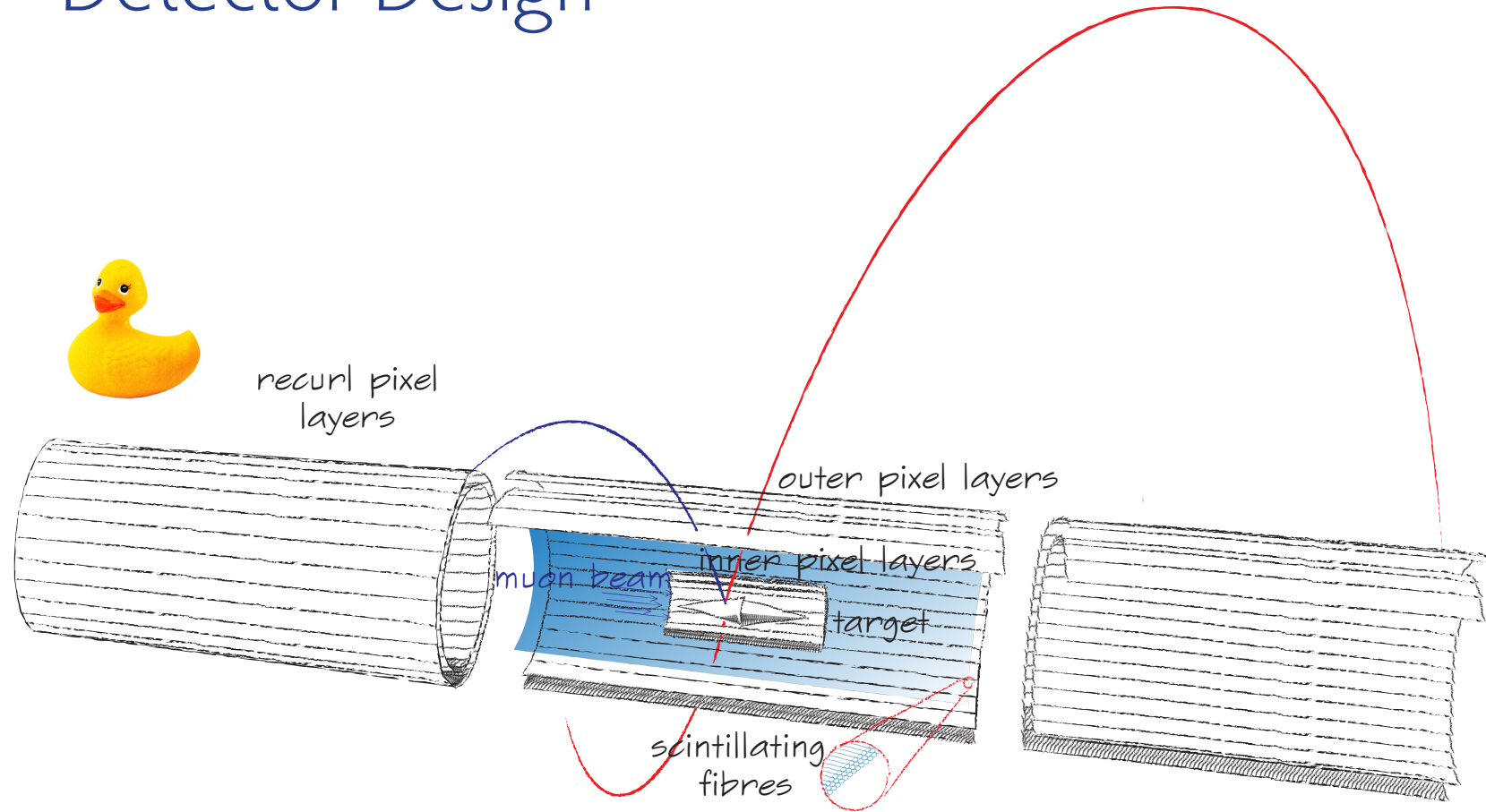




Long thin tube detector: Integration challenges

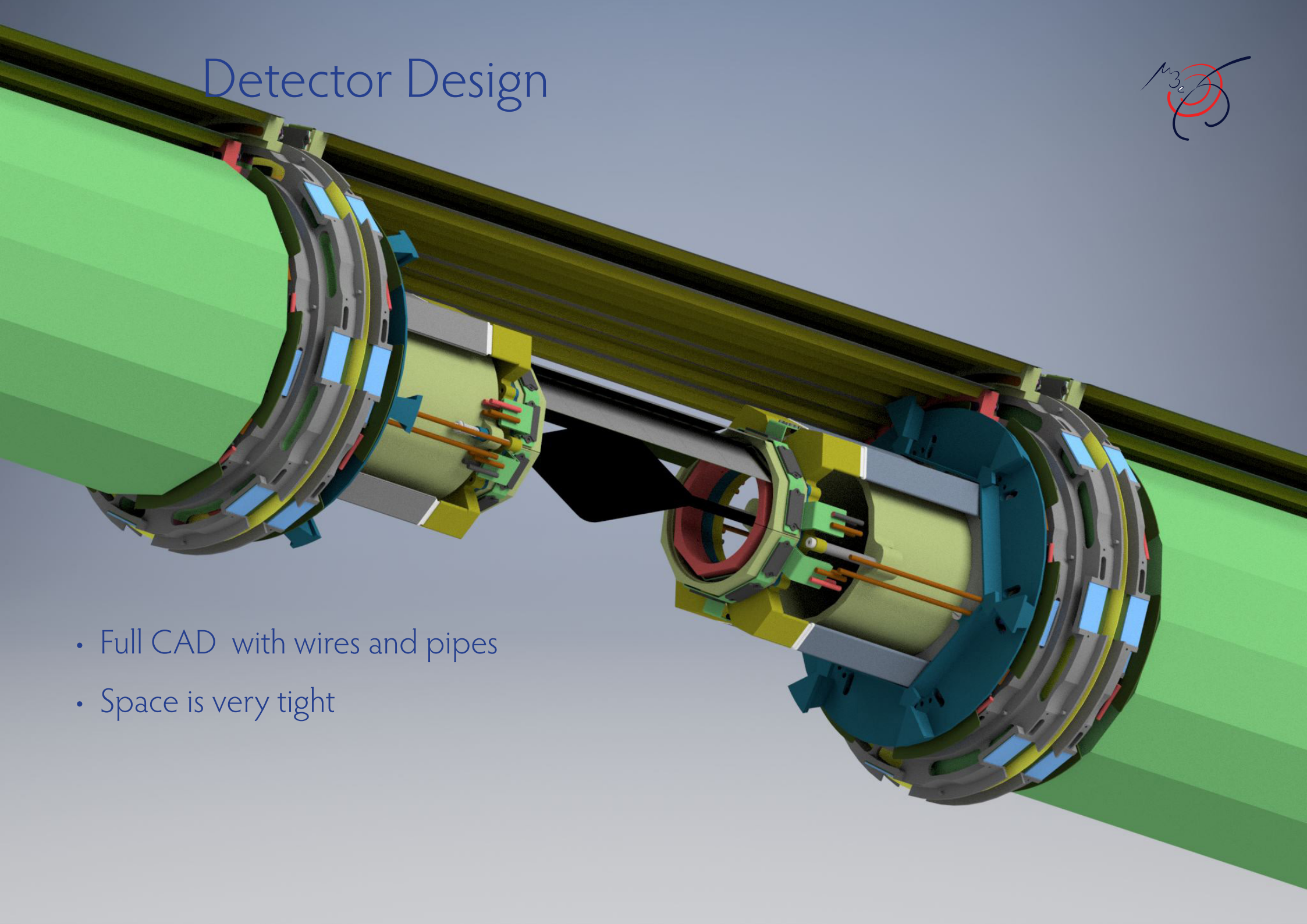


Detector Design

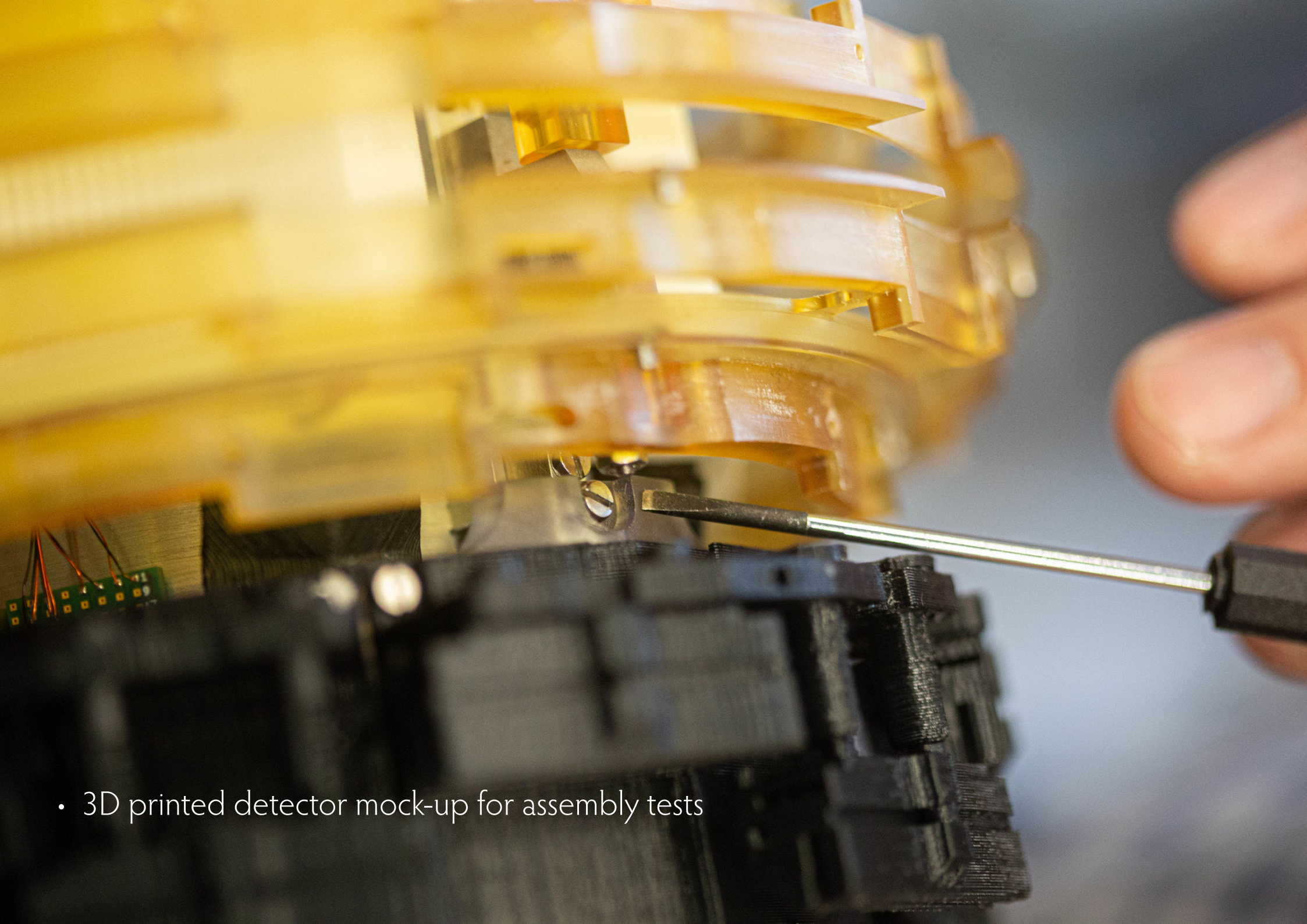


All services for all subdetectors around the beam pipe in the recurl stations

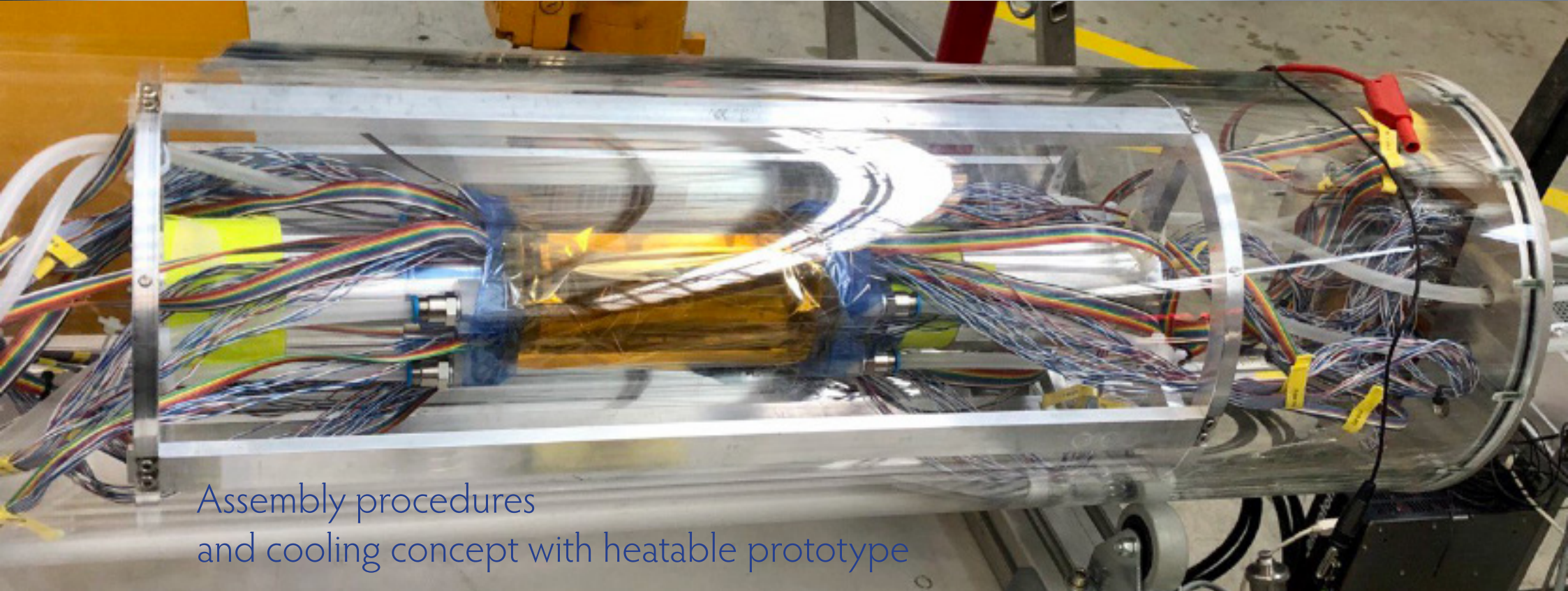
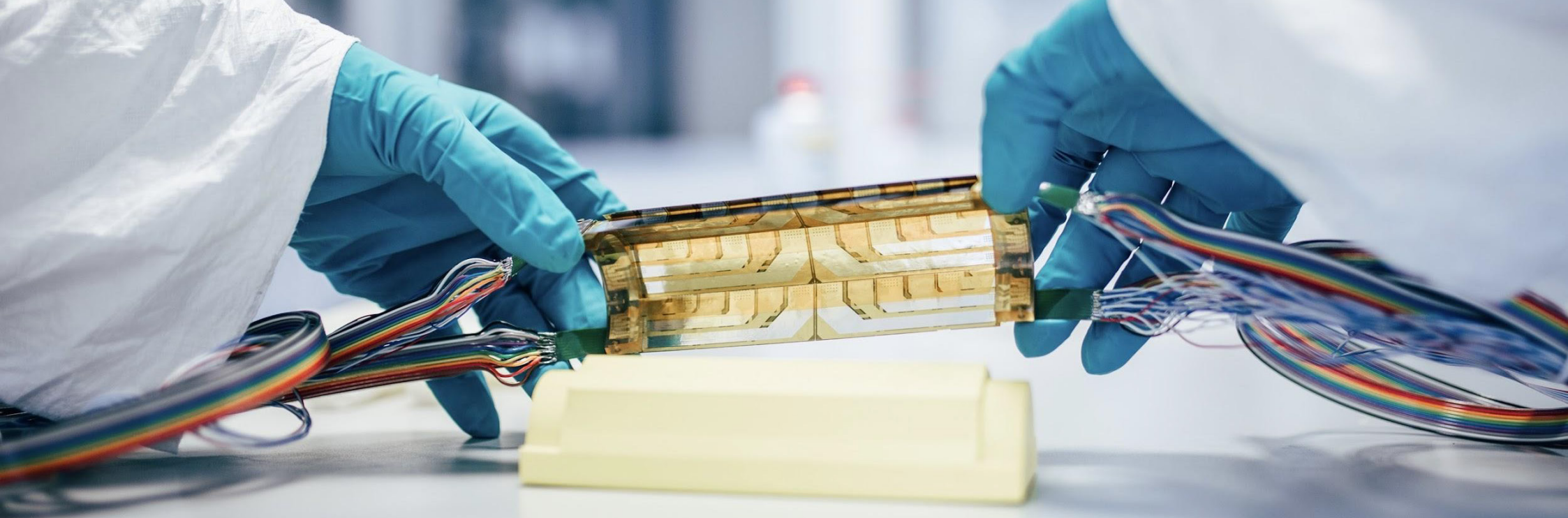
Detector Design



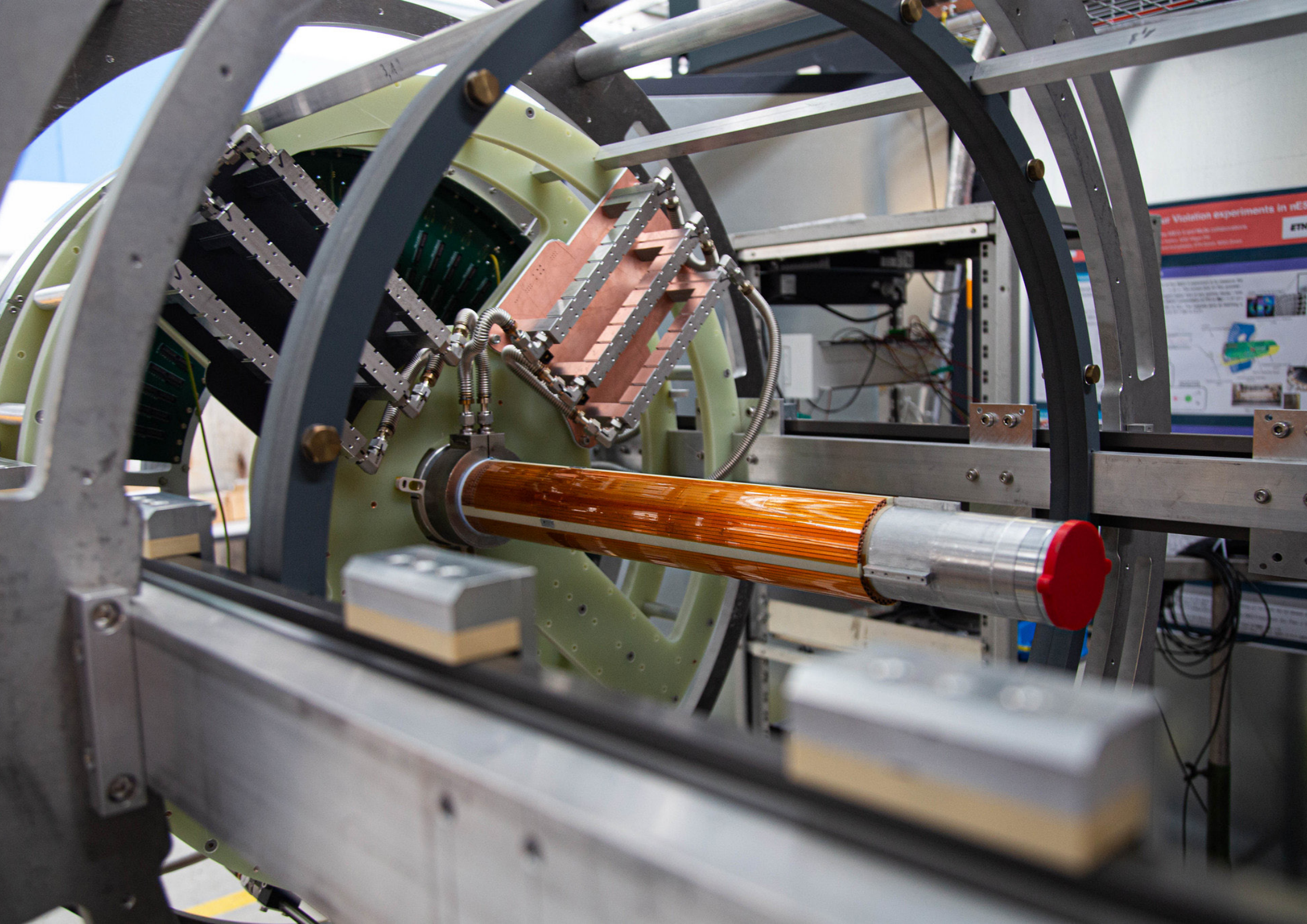
- Full CAD with wires and pipes
- Space is very tight



- 3D printed detector mock-up for assembly tests



Assembly procedures
and cooling concept with heatable prototype



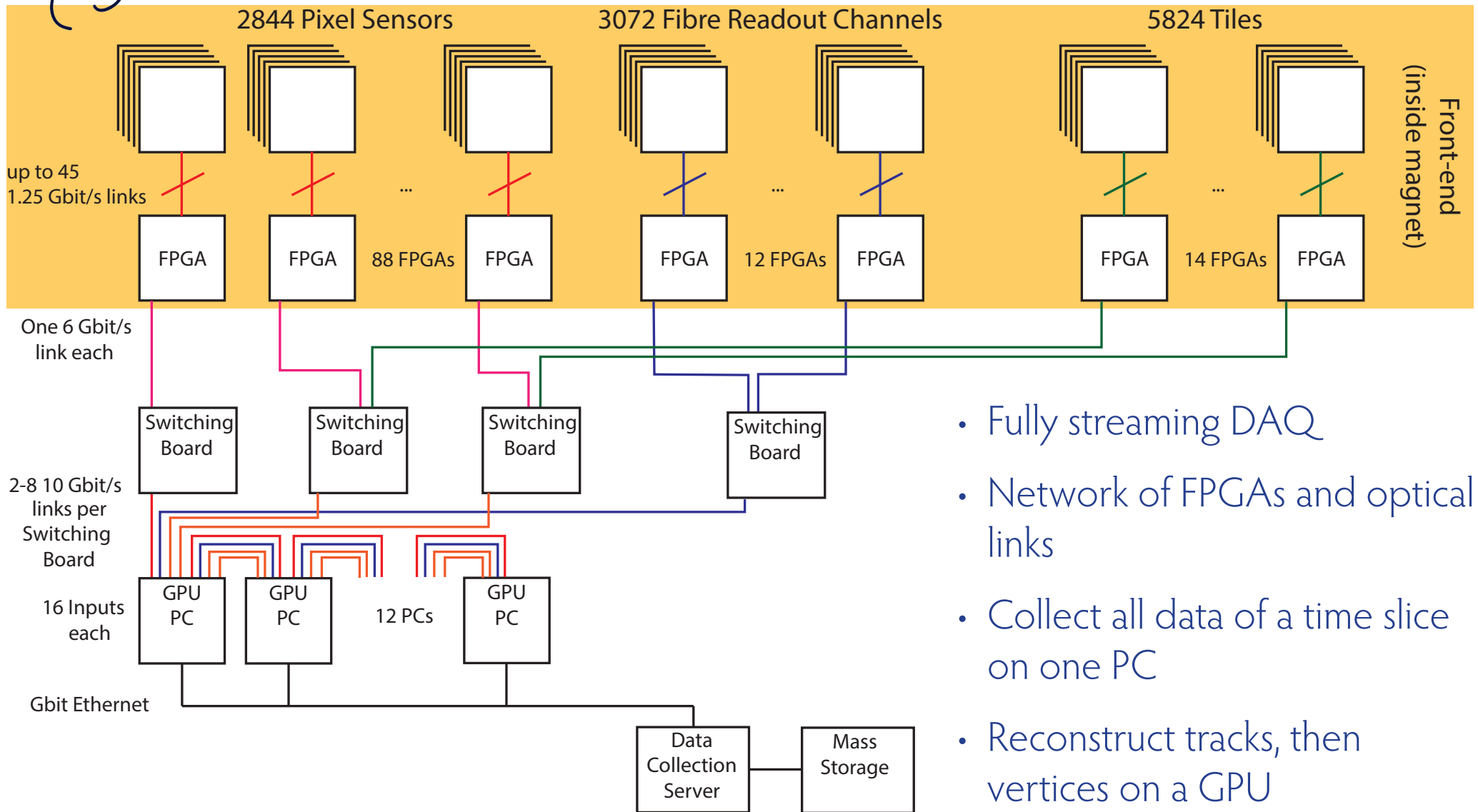




Data Acquisition



DAQ Design



- Fully streaming DAQ
- Network of FPGAs and optical links
- Collect all data of a time slice on one PC
- Reconstruct tracks, then vertices on a GPU
- Write interesting events to disk



GPU reconstruction



- GPU reconstruction on gaming cards
- Have achieved $> 10^9$ track fits/s per GPUs (Nvidia GTX 980)
- Twelve GTX 1080Ti are sufficient for dealing with 10^8 muon decays/s
- ~ 8 years pass
- Just four RTX 4090 can handle Mu3e phase I...

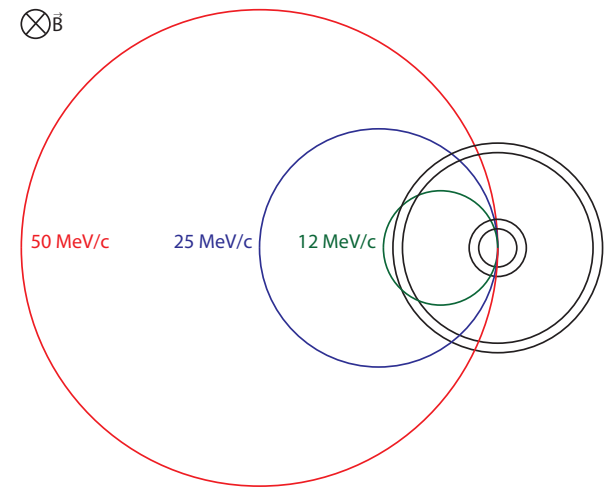


Performance simulation

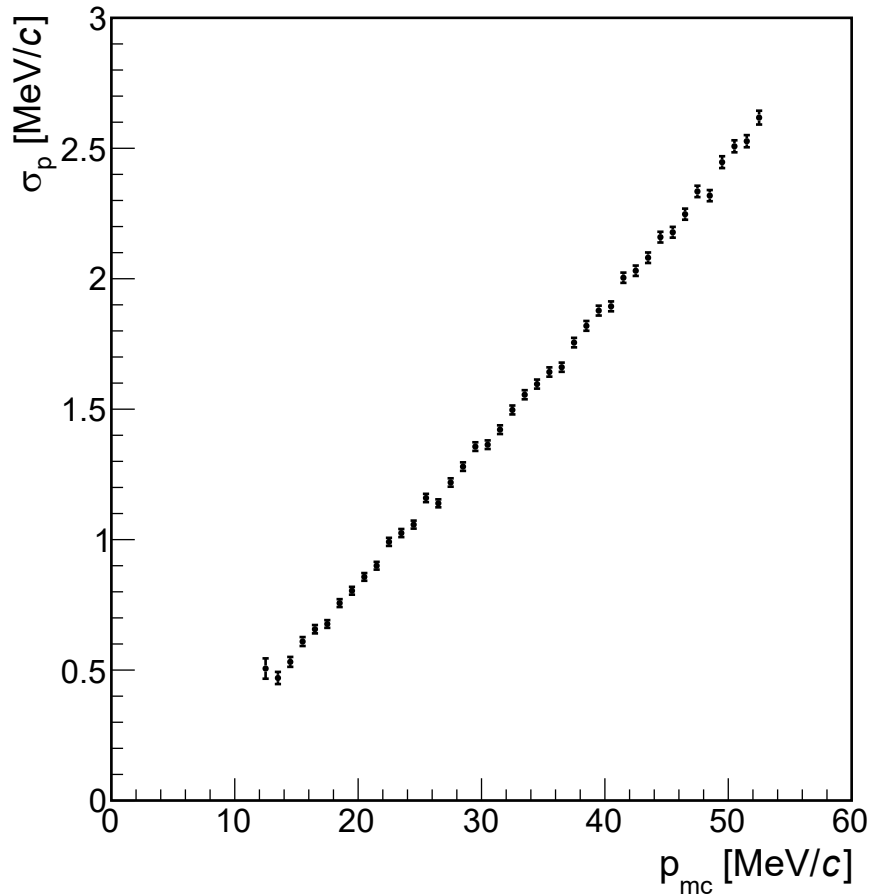


Momentum resolution

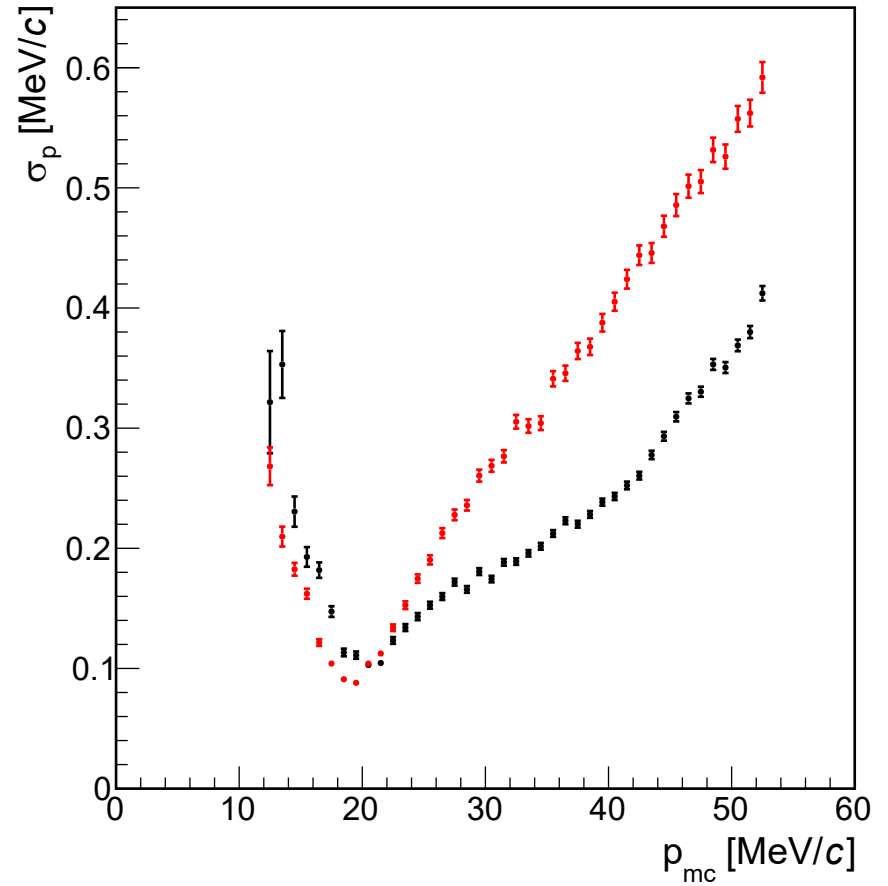
⊗ B



Outgoing part of tracks only

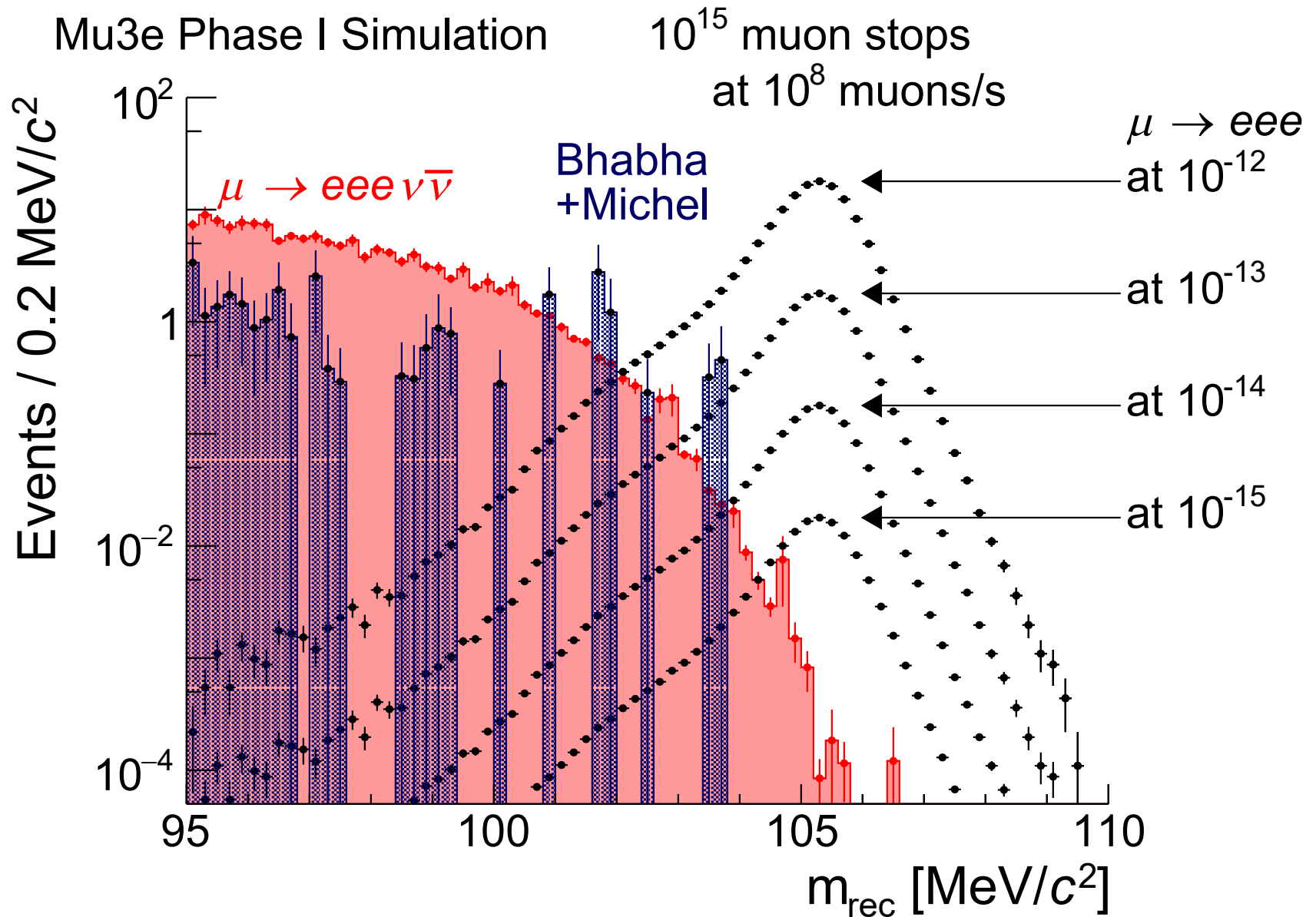


Recurling tracks



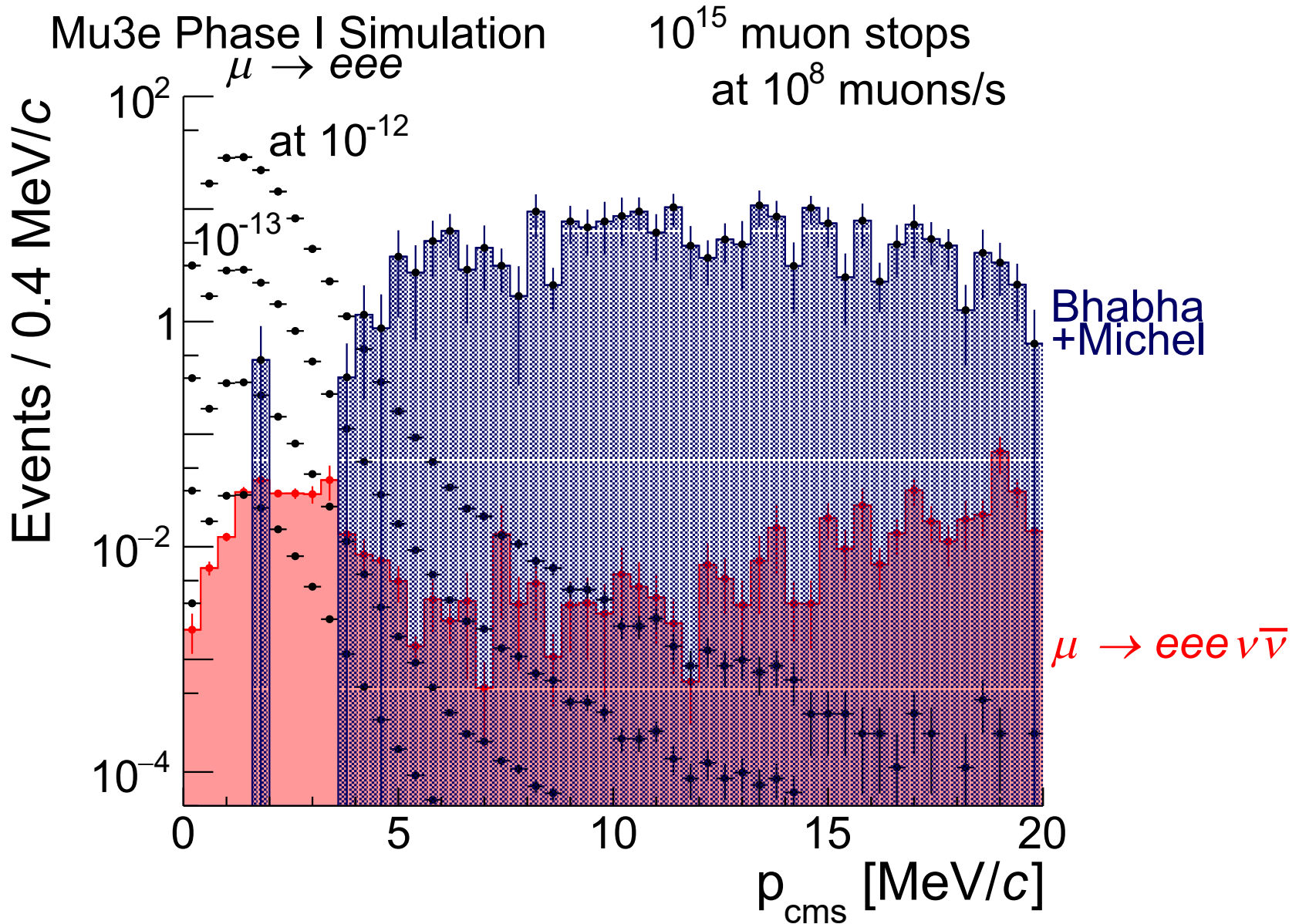


Mass distribution





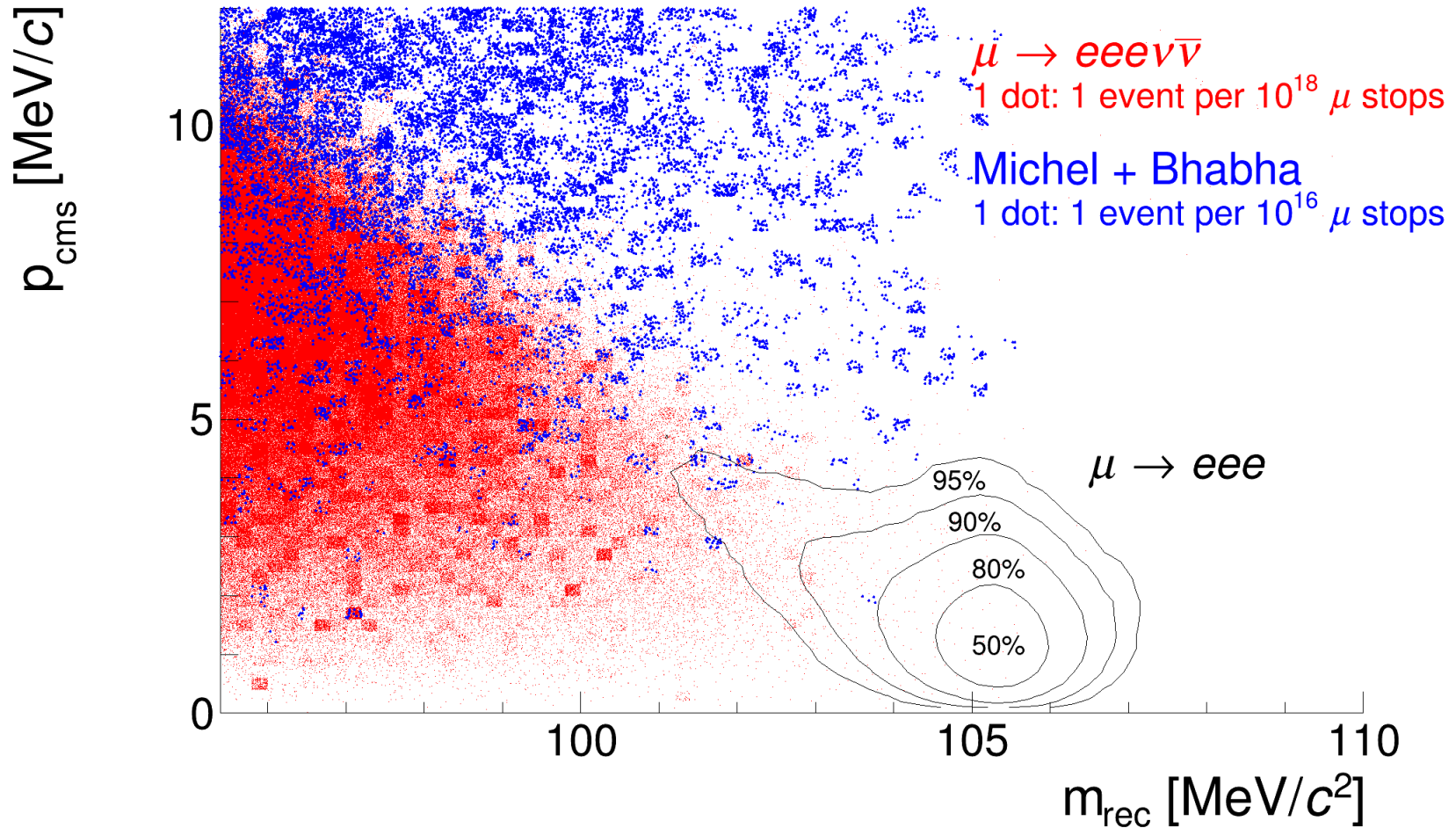
Momentum distribution





Mass/Momentum distribution

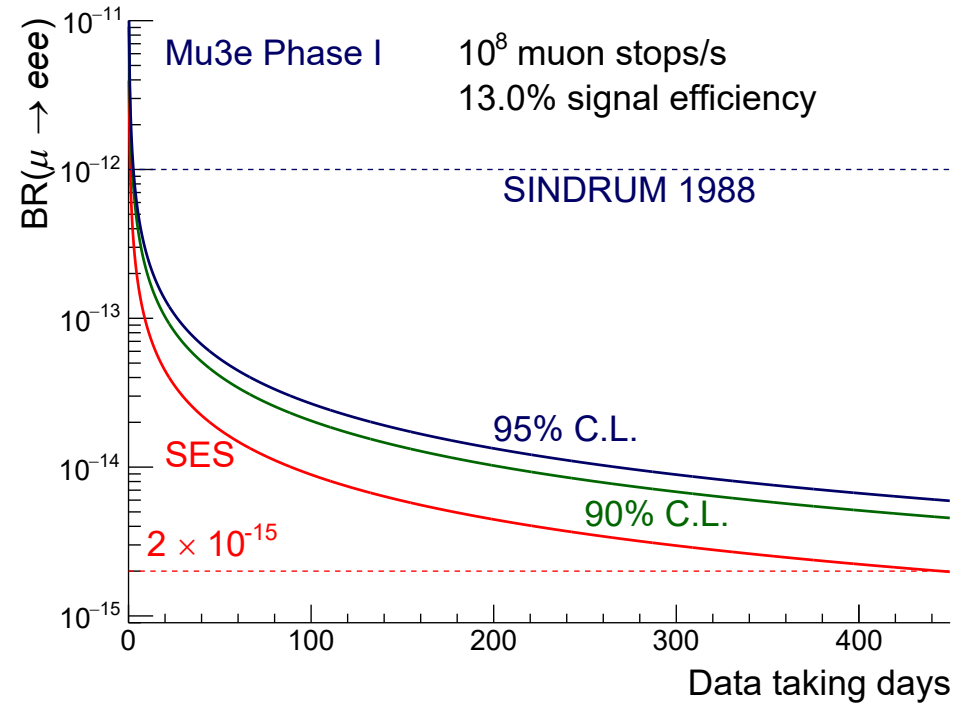
Mu3e Phase I Simulation





Sensitivity

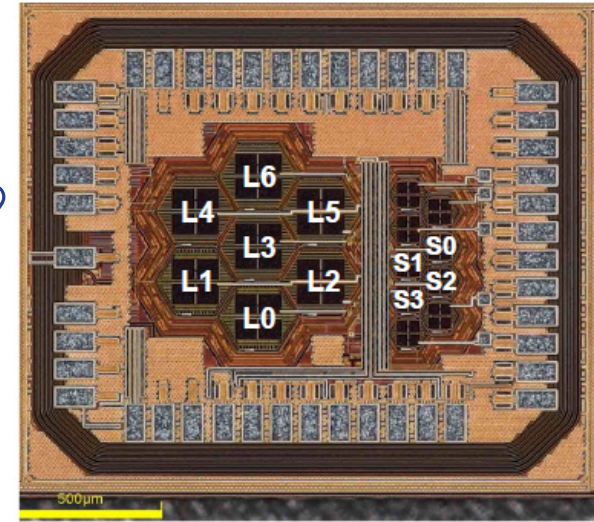
- Phase I expected SES is a few 10^{-15}
- Upgrade to high-intensity muon beam line likely in 2027
- 20 times more beam:
A lot of new challenges
- Gradual transition to Phase II





Phase II requirements and ideas

G. Iacobucci et al. 2019
JINST 14 P11008

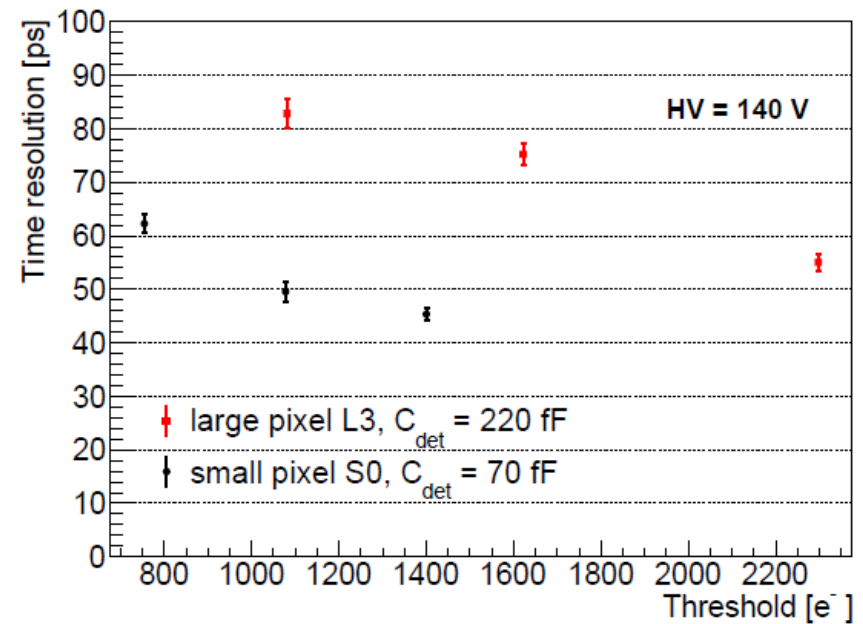


Better timing:

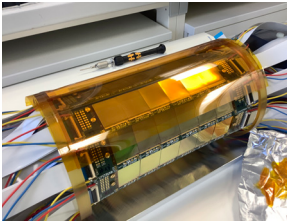
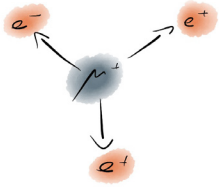
- Replace scintillating fibres by super-fast pixel detector $O(100 \text{ ps})$ (SiGe, gain layer,...)
- Push HV-MAPS timing to $O(1 \text{ ns})$

More acceptance, less material:

- Longer pixel modules
- Carbon fibre supports
- Serial powering
- Chip-to-chip communication
- ...



Conclusion



- Mu3e aims for $\mu \rightarrow eee$ at the 10^{-16} level
- First large scale use of HV-MAPS
- Build detector layers thinner than a hair
- Timing at the 100 ps level
- Reconstruct $>10^8$ tracks/s in ~ 100 Gbit/s on ~ 4 GPUs
- Integration and commissioning 2024/25
- ... and then finally data!

